

PCA8537

Automotive LCD driver for multiplex rates up to 1:8

Rev. 2 — 7 April 2015

Product data sheet

1. General description

The PCA8537 is a fully featured Liquid Crystal Display (LCD)¹ driver, specifically designed for high-contrast Vertical Alignment (VA) LCD with multiplex rates up to 1:8. It generates the drive signals for any static or multiplexed LCD containing up to eight backplanes, 46 segments, and up to 352 elements. The PCA8537 features an internal charge pump with internal capacitors for on-chip generation of the LCD driving voltage. To ensure an optimal and stable contrast over the full temperature range, the PCA8537 offers a programmable temperature compensation of the LCD supply voltage. The PCA8537 can be easily connected to a microcontroller by either the two-line I²C-bus (PCA8537AH) or a three-line bidirectional SPI-bus (PCA8537BH).

For a selection of NXP LCD segment drivers, see Table 43 on page 72.

2. Features and benefits

- AEC Q100 compliant for automotive applications.
- Low-power single-chip LCD controller and driver
- 352 elements allowing to drive:
 - up to 44 7-segment alphanumeric characters
 - up to 22 14-segment alphanumeric characters
- Selectable backplane drive configuration: static, 2, 4, 6, or 8 backplane multiplexing
- Software programmable internal charge pump for on-chip LCD voltage generation up to 9 V with internal capacitors
- 400 kHz I²C-bus interface (PCA8537AH)
- 5 MHz SPI-bus interface (PCA8537BH)
- Programmable temperature compensation of V_{LCD} in four regions
- Selectable display bias configuration
- Wide range for digital power supply: from 1.8 V to 5.5 V
- Wide LCD supply range: from 2.5 V for low threshold LCDs and up to 9.0 V for high threshold twisted nematic LCDs
- Display memory bank switching in static, duplex, and quadruplex drive modes
- 352-bit RAM for display data storage
- Programmable frame frequency in the range of 60 Hz to 300 Hz in steps of 10 Hz; factory calibrated
- Integrated temperature sensor with temperature readout
- On chip calibration of internal oscillator frequency and V_{LCD}
- Manufactured in silicon gate CMOS process

^{1.} The definition of the abbreviations and acronyms used in this data sheet can be found in Section 20.



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3. Applications

- Instrument cluster
- Car radio
- Climate control units

4. Ordering information

Table 1. Ordering information

Type number	Interface type	Package		
		Name	Description	Version
PCA8537AH	I ² C-bus	TQFP64	plastic thin quad flat package; 64 leads; body 10 × 10 × 1.0 mm	SOT357-1
PCA8537BH	SPI-bus	TQFP64	plastic thin quad flat package; 64 leads; body 10 × 10 × 1.0 mm	SOT357-1

4.1 Ordering options

Table 2. Ordering options

Product type number	Orderable part number	Sales item (12NC)	Delivery form	IC revision
PCA8537AH/Q900/1	PCA8537AH/Q900/1,5	935297895518	tape and reel, 13 inch, dry pack	1
PCA8537BH/Q900/1	PCA8537BH/Q900/1,5	935297896518	tape and reel, 13 inch, dry pack	1

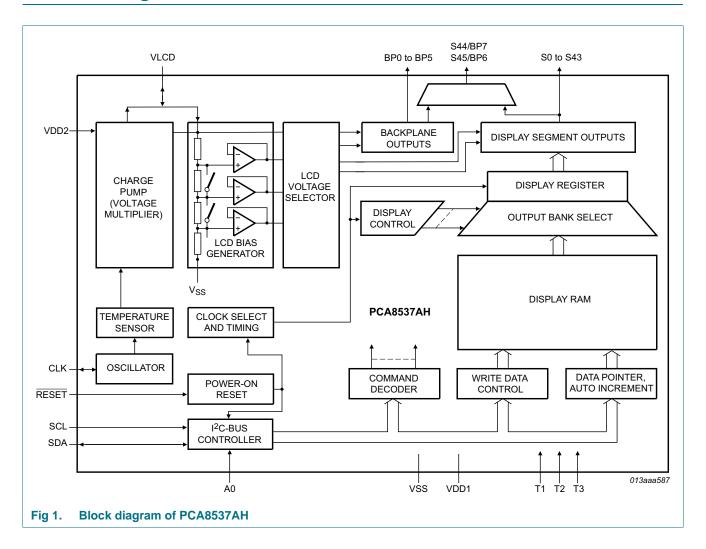
5. Marking

Table 3. Marking codes

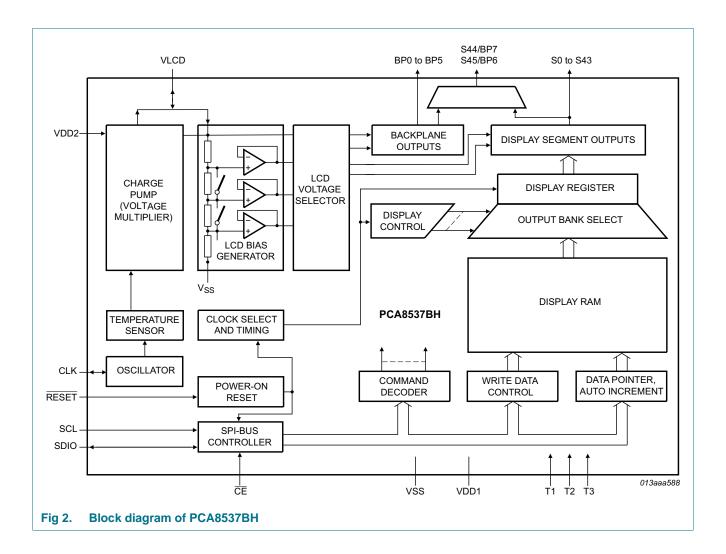
Type number	Marking code
PCA8537AH/Q900/1	PCA8537AH
PCA8537BH/Q900/1	PCA8537BH

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6. Block diagram



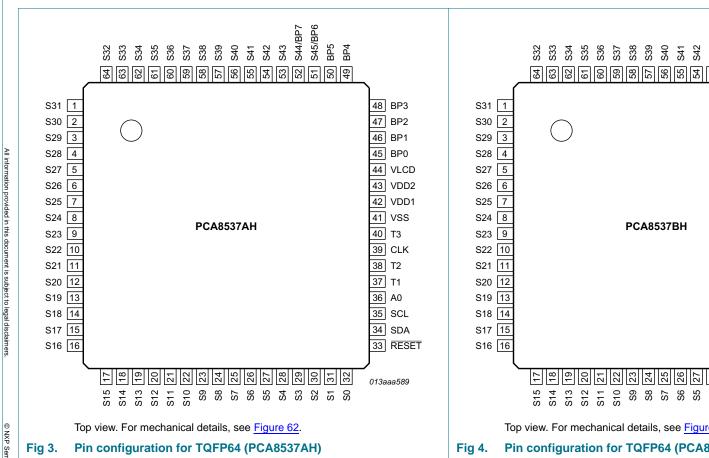
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Pinning information 7.

7.1 **Pinning**



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7.2 Pin description

Table 4. Pin description of PCA8537AH and PCA8537BH

Input or input/output pins must always be at a defined level (V_{SS} or V_{DD}) unless otherwise specified.

Pin	Symbol		Туре	Description	
	PCA8537AH	PCA8537BH	_		
1 to 32	S31	to S0	output	LCD segments	
33	RES	SET	input	active low reset input	
34	SDA		input/output	I ² C-bus serial data	
		CE	input	SPI-bus chip enable - active LOW	
35	SCL		input	I ² C-bus serial clock	
		SCL	input	SPI-bus serial clock	
36	A0		input	I ² C-bus slave address selection	
		SDIO	input/output	SPI-bus serial data	
37, 38, 40	T1 t	T1 to T3		test pins; must be tied to V _{SS} in applications	
39	CI	LK	input/output	internal oscillator output, external oscillator input	
41	VS	SS	supply	ground supply	
42	VD	D1	supply	supply voltage 1	
43	VD	D2	supply	supply voltage 2	
44	VLC	D[1]	supply	LCD supply[2]	
45 to 50	BP0 to BP5		output	LCD backplanes	
51	S45/BP6		output	LCD segments for 1:6 multiplex drive mode;	
52	S44 <i>i</i>	/BP7	output	LCD backplanes for 1:8 multiplex drive mode	
53 to 64	S43 t	o S32	output	LCD segments	

^[1] V_{LCD} must be equal to or greater than V_{DD2} .

^[2] When the internal V_{LCD} generation is used, this pin drives the V_{LCD} voltage. In this case pin VLCD is an output. When the external supply is requested, then pin VLCD is an input and V_{LCD} can be supplied on it. In this case, the internal charge pump must be disabled (see <u>Table 9</u>).

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8. Functional description

The PCA8537 is a versatile peripheral device designed to interface any microcontroller to a wide variety of LCDs. It can directly drive any static or multiplexed LCD containing up to 352 elements.

8.1 Commands of PCA8537

The commands to control the PCA8537 are defined in <u>Table 5</u>. Any other combinations of operation code bits that are not mentioned in this document can lead to undesired operation modes of PCA8537.

Table 5. Commands of PCA8537 *The bit labeled with - is not implemented.*

Command name	RS[1]	Bits								Reference
		7	6	5	4	3	2	1	0	-
Initialize	0	0	0	1	1	1	0	1	0	Section 8.1.1
OTP-refresh	0	1	1	0	1	0	0	0	0	Section 8.1.2
Oscillator-ctrl	0	1	1	0	0	1	1	COE	OSC	Section 8.1.3
Charge-pump-ctrl	0	1	1	0	0	0	0	CPE	CPC	Section 8.1.4
Temp-msr-ctrl	0	1	1	0	0	1	0	TCE	TME	Section 8.1.5
Temp-comp	0	0	0	0	1	1	SLA[2:0	0]		Section 8.1.6
	0	0	0	1	0	0	SLB[2:0	0]		
	0	0	0	1	0	1	SLC[2:	0]		
	0	0	0	1	1	0	SLD[2:	0]		
Set-VPR	0	0	1	0	0	VPR[7:	4]			Section 8.1.7
	0	0	1	0	1	VPR[3:	0]			
Display-enable	0	0	0	1	1	1	0	0	Е	Section 8.1.8
Set-MUX-mode	0	0	0	0	0	0	M[2:0]			Section 8.1.9
Set-bias-mode	0	1	1	0	0	0	1	B[1:0]		<u>Section 8.1.10</u>
Load-data-pointer	0	1	0	P[5:0]]					<u>Section 8.1.11</u>
Frame-frequency	0	0	1	1	F[4:0]					<u>Section 8.1.12</u>
Bank-select	0	0	0	0	0	1	0	IBS	OBS	<u>Section 8.1.13</u>
Write-RAM-data	1	B[7:0]	B[7:0]				<u>Section 8.1.14</u>			
Temp-read	-	TD[7:	0]							<u>Section 8.1.15</u>
Invmode_ctrl	0	1	1	0	1	0	1	LF	0	<u>Section 8.1.16</u>
Temp-filter	0	1	1	0	1	0	0	1	TFE	<u>Section 8.1.17</u>

^[1] For further information about the register selection bit, see <u>Table 31 on page 50</u>.

8.1.1 Command: Initialize

This command generates a chip-wide reset which resets all command values to their default values. After this command is sent, it is possible to send additional commands without the need to re-initialize the interface. The reset takes 100 ns to complete.

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Table 6. Initialize - initialize command bit description For further information, see Section 8.2 on page 16.

Bit	Symbol	Binary value	Description
7 to 0	-	00111010	fixed value

8.1.2 Command: OTP-refresh

During production and testing of the device, each IC is calibrated to achieve the specified accuracy of V_{LCD} , the frame frequency, and the temperature measurement. This calibration is performed on EPROM cells called One Time Programmable (OTP) cells.

The device reads these cells every time at power-on, after a reset, and every time when the initialize command or the OTP-refresh command is sent.

Remark: It is recommended not to enter power-down mode during the OTP refresh cycle.

Table 7. OTP-refresh - OTP-refresh command bit description

Bit	Symbol	Binary value	Description
7 to 0	-	11010000	fixed value

8.1.3 Command: Oscillator-ctrl

The Oscillator-ctrl command switches between internal and external oscillator and enables or disables the pin CLK.

Table 8. Oscillator-ctrl - oscillator control command bit description For further information, see Section 8.1.3.1.

Bit	Symbol	Binary value	Description
7 to 2	-	110011	fixed value
1	COE		control pin CLK
		O[1]	clock signal not available on pin CLK; pin CLK is in 3-state and may be left floating
		1	clock signal available on pin CLK
0	OSC		oscillator source
		0[1]	internal oscillator used
		1	external oscillator used; pin CLK becomes an input

^[1] Default value.

8.1.3.1 Oscillator

The internal logic and LCD drive signals of the PCA8537 are timed either by the built-in oscillator or from an external clock.

8.1.3.2 Internal oscillator

When the internal oscillator is used, it is possible to make the clock signal available on pin CLK by using the Oscillator-ctrl command (see <u>Table 8</u>). If this is not intended, the pin CLK should be left open. At power-on the signal at pin CLK is disabled and pin CLK is in 3-state.

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If the internal charge pump is enabled, then the internal oscillator starts and is used to run the charge pump. An external oscillator can still be applied for driving the display waveforms.

The duty cycle of the output clock provided on the CLK pin is not always 50 : 50. <u>Table 18</u> on page 13 shows the expected duty cycle for each of the chosen frame frequencies.

8.1.3.3 External clock

In applications where an external clock must be applied to the PCA8537, bit OSC (see <u>Table 8</u>) must be set logic 1. In this case, pin CLK becomes an input.

The CLK signal is a signal that is fed into the V_{DD1} domain. Therefore it must have an amplitude equal to the V_{DD1} voltage supplied to the chip and be referenced to V_{SS} .

The clock frequency (f_{clk}) determines the LCD frame frequency.

Remark: If an external clock is used then this clock signal must always be supplied to the device. Removing the clock can freeze the LCD in a DC state. Removal of the clock is possible when following the correct procedures (see <u>Figure 11 on page 21</u> and <u>Figure 12 on page 22</u>).

8.1.4 Command: Charge-pump-ctrl

The Charge-pump-ctrl command enables or disables the internal V_{LCD} generation and controls the charge pump voltage multiplier setting.

Table 9. Charge-pump-ctrl - charge pump control command bit description For further information, see Table 12 on page 11 and Section 8.4.3 on page 26.

Bit	Symbol	Binary value	Description
7 to 2	-	110000	fixed value
1	CPE		charge pump switch
		0[1]	charge pump disabled; no internal V _{LCD} generation; external supply of V _{LCD}
		1	charge pump enabled
0	CPC		charge pump voltage multiplier setting
		0[1]	$V_{LCD} = 2 \times V_{DD2}$
		1	$V_{LCD} = 3 \times V_{DD2}$

[1] Default value.

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8.1.5 Command: Temp-msr-ctrl

The Temp-msr-ctrl command enables or disables the temperature measurement block and the temperature compensation of V_{LCD} .

Table 10. Temp-msr-ctrl - temperature measurement control command bit description For further information, see Section 8.4.4 on page 28.

Bit	Symbol	Binary value	Description
7 to 2	-	110010	fixed value
1	TCE		temperature compensation switch
		0	no temperature compensation of V _{LCD} possible
		1[1]	temperature compensation of V _{LCD} possible
0	TME		temperature measurement switch
		0	temperature measurement disabled:
			no temperature readout possible
		1 <u>[1]</u>	temperature measurement enabled:
			temperature readout possible

^[1] Default value.

8.1.6 Command: Temp-comp

The Temp-comp command allows setting the temperature compensation coefficients for each of the temperature regions SFA to SFD. For further information, see Section 8.4.4.2.

Table 11. Temp-comp - temperature compensation coefficients command For further information, see <u>Section 8.4.4 on page 28</u>.

Bit	Symbol	Binary value	Description		
SLA					
7 to 3	-	00011	fixed value		
2 to 0	SLA[2:0]	000 ^[1] to 111	temperature compensation coefficient SLA, see Table 27 on page 30		
SLB					
7 to 3	-	00100	fixed value		
2 to 0	SLB[2:0]	000 ^[1] to 111	temperature compensation coefficient SLB, see Table 27 on page 30		
SLC					
7 to 3	-	00101	fixed value		
2 to 0	SLC[2:0]	000 ^[1] to 111	temperature compensation coefficient SLC, see Table 27 on page 30		
SLD					
7 to 3	-	00110	fixed value		
2 to 0	SLD[2:0]	000 ^[1] to 111	temperature compensation coefficient SLD, see Table 27 on page 30		

^[1] Default value.

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8.1.7 Command: Set-VPR

With these two instructions, it is possible to set the target V_{LCD} voltage for the internal charge pump.

Table 12. Set-VPR - set VPR command bit description

For further information, see Section 8.4.2 on page 24.

Bit	Symbol	Binary value	Description
Set-VP	-	Dinary value	2000 Ipiloli
7 to 4	-	0100	fixed value
3 to 0	VPR[7:4]	0000[1] to 1111[2]	the four most significant bits of VPR[7:0]
Set-VP	R LSB		
7 to 4	-	0101	fixed value
3 to 0	VPR[3:0]	0000[1] to 1111[2]	the four least significant bits of VPR[7:0]

^[1] Default value.

8.1.8 Command: Display-enable

This command allows switching the display on and off. The possibility to disable and enable the display allows implementation of blinking the entire display under external control.

Table 13. Display-enable - display enable command bit description

Bit	Symbol	Binary value	Description		
7 to 1	-	0011100	fixed value		
0	Е	0[1]	display disabled		
			backplane and segment outputs are internally connected to $\ensuremath{\text{V}_{\text{SS}}}$		
		1	display enabled		

[1] Default value.

 $^{[2] \}quad \text{VPR[7:0] = 0h results in V}_{\text{prog(LCD)}} = 3 \text{ V;}$ $\text{VPR[7:0] = C8h results in V}_{\text{prog(LCD)}} = 9 \text{ V.}$

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8.1.9 Command: Set-MUX-mode

The multiplex drive mode is configured with the bits described in Table 14.

Table 14. Set-MUX-mode - set multiplex drive mode command bit description For further information, see Section 8.4.5 on page 31.

Bit	Symbol	Binary value	Description
7 to 3	-	00000	fixed value
2 to 0	M[2:0]	000 <u>[1]</u> 011 101 111	1:8 multiplex drive mode 8 backplanes and 44 segments
		110	1:6 multiplex drive mode 6 backplanes and 46 segments
		100	1:4 multiplex drive mode 4 backplanes and 44 segments
		010	1:2 multiplex drive mode 2 backplanes and 44 segments
		001	static drive mode 1 backplane and 44 segments

^[1] Default value.

8.1.10 Command: Set-bias-mode

The Set-bias-mode command allows setting the bias level.

Table 15. Set-bias-mode - set bias mode command bit description For further information, see Section 8.4.5 on page 31.

Bit	Symbol	Binary value	Description		
7 to 2	-	110001	fixed value		
1 to 0	B[1:0]		LCD bias configuration[1]		
		00[2]	$\frac{1}{4}$ bias		
		01			
		11	$\frac{1}{3}$ bias		
		10	$\frac{1}{2}$ bias		

^[1] Not applicable for static drive mode.

8.1.11 Command: Load-data-pointer

The Load-data-pointer command defines the display RAM address where the following display data will be sent to.

Table 16. Load-data-pointer - load data pointer command bit description For further information, see <u>Section 8.8 on page 43</u>.

Bit	Symbol	Binary value	Description
7 to 6	-	10	fixed value
5 to 0	P[5:0]	000000 to 101101	RAM address 6-bit binary value of 0 to 45

^[2] Default value.

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8.1.12 Command: Frame-frequency

With the Frame-frequency command, the frame frequency and the output clock frequency can be configured.

Table 17. Frame frequency - frame frequency and output clock frequency command bit description

Bit	Symbol	Binary value	Description
7 to 5	-	011	fixed value
4 to 0	F[4:0]	see <u>Table 18</u>	frame frequency values, see Table 18

Table 18. Frame frequency values

F[4:0]	Nominal frame frequency f _{fr} (Hz)[1]	Resultant output clock frequency, f _{clk(o)} (Hz)	Duty cycle (%)[2]
00000	60	2880	20:80
00001	70	3360	7:93
00010	80	3840	47 : 53
00011	91	4368	40 : 60
00100	100	4800	33 : 67
00101	109	5232	27 : 73
00110	120	5760	20:80
00111	129.7	6226	13:87
01000	141.2	6778	5:95
01001	150	7200	50 : 50
01010	160	7680	47 : 53
01011	171.4	8227	43 : 57
01100	177.8	8534	41 : 59
01101	192	9216	36 : 64
01110 <mark>^[3]</mark>	200	9600	33 : 67
01111	208.7	10018	30 : 70
10000	218.2	10474	27:73
10001	228.6	10973	23:77
10010	240	11520	20:80
10011	252.6	12125	16 : 84
10100, 10101	266.7	12802	10:90
10110, 10111	282.4	13555	5:95
11000 to 11111	300	14400	50 : 50

^[1] Nominal frame frequency calculated for the default clock frequency of 9600 Hz.

^[2] Duty cycle definition: % HIGH-level time : % LOW-level time.

^[3] Default value.

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8.1.12.1 Timing and frame frequency

The timing of the PCA8537 organizes the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. The timing also generates the LCD frame frequency. The frame frequency is a fixed division of the internal clock or of the frequency applied to pin CLK when an external clock is used.

When the internal clock is used, the clock frequency can be programmed by software such that the nominal frame frequency can be chosen in steps of 10 Hz in the range of 60 Hz to 300 Hz (see <u>Table 18</u>). Furthermore the nominal frame frequency is factory-calibrated with an accuracy of ±15 %.

When the internal clock is enabled at pin CLK by using bit COE, the duty ratio of the clock may change when choosing different values for the frame frequency prescaler. <u>Table 18</u> shows the different output duty ratios for each frame frequency prescaler setting.

8.1.13 Command: Bank-select

For the multiplex drive modes 1:4, 1:2, and the static drive mode, it is possible to write data to one area of the RAM while displaying from another. These areas are named RAM banks. There are two banks, 0 and 1. Figure 39 on page 49 and Figure 40 on page 49 show the concept. The Bank-select command controls where data is written to and where it is displayed from.

Table 19. Bank-select - bank select command bit description For further information, see Section 8.9 on page 49.

Bit	Symbol	Binary value	Description	
7 to 2	-	000010	fixed value	
1	IBS	selects RAM bank to write to		
		0[1]	Bank 0	
		1	Bank 1	
0	OBS		selects RAM bank to read from to the LCD	
		0[1]	Bank 0	
		1	Bank 1	

^[1] Default value.

8.1.14 Command: Write-RAM-data

By setting the RS bit of the control byte to logic 1, all data transferred is interpreted as RAM data and placed in the RAM in accordance with the current setting of the RAM address pointer (see Section 8.1.11 on page 12). Definition of the RS can be found in Table 31 on page 50.

Remark: After Power-On Reset (POR) the RAM content is random and should be brought to a defined status by clearing it (setting it to logic 0).

Table 20. Write-RAM-data - write RAM data command bit description For further information, see Section 8.8 on page 43.

Bit	Symbol	Binary value	Description
7 to 0	B[7:0]	00000000 to 11111111	writing data byte-wise to the RAM

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8.1.15 Command: Temp-read

The Temp-read command allows reading out the temperature values measured by the internal temperature sensor.

Table 21. Temp-read - temperature readout command bit description For further information, see Section 8.4.4 on page 28.

Bit	Symbol	Binary value	Description
7 to 0	TD[7:0]	00000000 to 11111111	digital temperature values ^[1]

^[1] For this command, bit R/\overline{W} of the I^2C -bus slave address byte has to be set logic 1 (see Table 32).

8.1.16 Command: Invmode ctrl

The Invmode_ctrl command allows changing the drive scheme inversion mode.

The waveforms used to drive LCD displays inherently produce a DC voltage across the display cell. The PCA8537 compensates for the DC voltage by inverting the waveforms on alternate frames or alternate lines. The choice of compensation method is determined with the LF bit.

Table 22. Invmode_ctrl - drive scheme inversion command bit description For further information, see <u>Section 8.4.6 on page 34.</u>

Bit	Symbol	Binary value	Description			
7 to 2	-	110101	fixed value			
1	LF		set inversion mode			
		0[1]	driving scheme A: line inversion mode			
		1	driving scheme B: frame inversion mode			
0	-	0	fixed value			

^[1] Default value.

In frame inversion mode, the DC value is compensated across two frames and not within one frame. Changing the inversion mode to frame inversion reduces the power consumption, therefore it is useful when power consumption is a key point in the application.

Frame inversion may not be suitable for all applications. The RMS voltage across a segment is better defined, however since the switching frequency is reduced there is possibility for flicker to occur.

<u>Figure 24 on page 34</u> to <u>Figure 30 on page 40</u> are showing the waveforms in line inversion mode. Figure 31 on page 41 shows an example of frame inversion.

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8.1.17 Command: Temp-filter

Table 23. Temp-filter - digital temperature filter command bit description For further information, see Section 8.4.4 on page 28.

Bit	Symbol	Binary value	Description
7 to 1	-	1101001	fixed value
0	TFE		digital temperature filter switch
		0[1]	digital temperature filter disabled; the unfiltered digital value of TD[7:0] is immediately available for the readout and V _{LCD} compensation, see Section 8.4.4.1
		1	digital temperature filter enabled

^[1] Default value.

8.2 Start-up and shut-down

8.2.1 Power-On Reset (POR)

At power-on, the PCA8537 resets to starting conditions as follows:

- 1. All backplane and segment outputs are set to V_{SS}.
- 2. Selected drive mode is: 1:8 with $\frac{1}{4}$ bias.
- 3. Input and output bank selectors are reset.
- 4. The I²C-bus and SPI-bus interface are initialized.
- 5. The data pointer is cleared (set logic 0).
- 6. The internal oscillator is running; no clock signal is available on pin CLK; pin CLK is in 3-state.
- 7. Temperature measurement is enabled.
- 8. Temperature filter is disabled.
- 9. The internal V_{LCD} voltage generation is disabled. The charge pump is switched off.
- 10. The V_{LCD} temperature compensation is enabled.
- 11. The display is disabled.

The reset state is as shown in Table 24.

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Table 24. Reset state

Reset state of configuration bits shown in the command table format for clarity. The bit labeled with - has an undefined reset state

Command name	Bits								
	7	6	5	4	3	2	1	0	
Oscillator-ctrl	1	1	0	0	1	1	COE = 0	OSC = 0	
Charge-pump-ctrl	1	1	0	0	0	0	CPE = 0	CPC = 0	
Temp-msr-ctrl	1	1	0	0	1	0	TCE = 1	TME = 1	
Temp-comp	0	0	0	1	1	SLA[2:0	0] = 000		
	0	0	1	0	0	SLB[2:0	0] = 000		
	0	0	1	0	1	SLC[2:0	SLC[2:0] = 000		
	0	0	1	1	0	SLD[2:0	SLD[2:0] = 000		
Set-VPR	0	1	0	0	VPR[7:	VPR[7:4] = 0000			
	0	1	0	1	VPR[3:	PR[3:0] = 0000			
Display-enable	0	0	1	1	1	0	0	E = 0	
Set-MUX-mode	0	0	0	0	0	M[2:0] :	= 000		
Set-bias-mode	1	1	0	0	0	1	B[1:0] = 0	0	
Load-data-pointer	1	0	P[5:0] is	s undefined	,	,	1		
Frame-frequency	0	1	1	F[4:0] =	F[4:0] = 01110				
Bank-select	0	0	0	0	1	0	IBS = 0	OBS = 0	
Invmode_ctrl	1	1	0	1	0	1	LF = 0	-	
Temp-filter	1	1	0	1	0	0	1	TFE = 0	

Remark: Do not transfer data on the I²C-bus or SPI-bus for at least 1 ms after a power-on reset to allow the reset action to complete.

The first command sent to the device after the power-on event must be the Initialize command (see Section 8.1.1).

After POR and before enabling the display, the RAM content should be brought to a defined status

- by clearing it (setting it all to logic 0) or
- by writing meaningful content (for example, a graphic)

otherwise unwanted display artifacts may appear on the display.

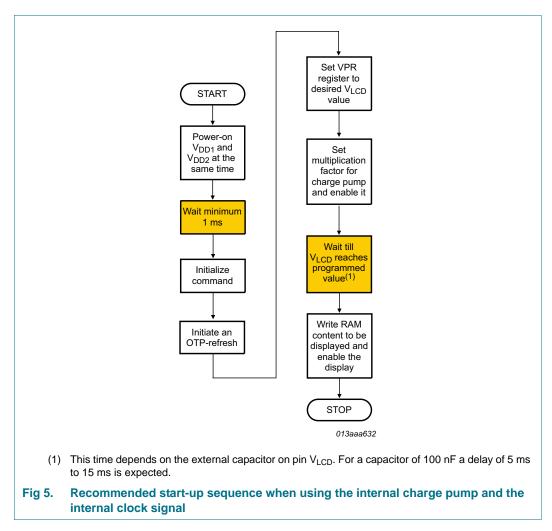
8.2.2 RESET pin function

The RESET pin of the PCA8537 resets all the registers to their default state. The reset state is given in <u>Table 24</u>. The RAM contents remain unchanged. After the reset signal is removed, the PCA8537 will behave in the same manner as after POR. See <u>Section 8.2.1</u> for details.

8.2.3 Recommended start-up sequences

This chapter describes how to proceed with the initialization of the chip in different application modes.

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If the display is enabled too soon after the charge pump is enabled, then the V_{LCD} voltage may not have yet stabilized leading to an uneven display effect.

Automotive LCD driver for multiplex rates up to 1:8

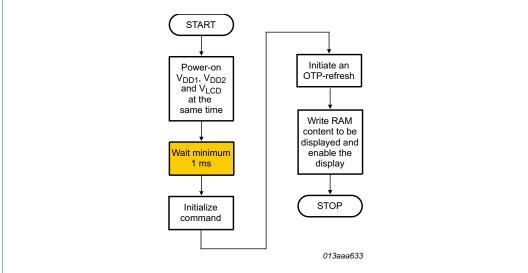
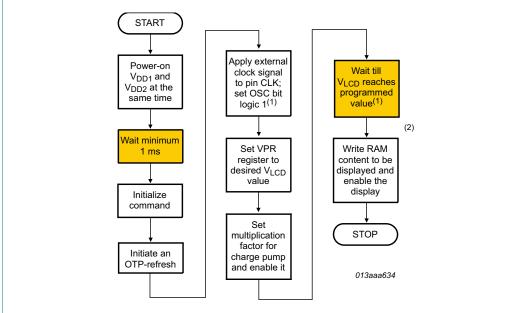


Fig 6. Recommended start-up sequence when using an external supplied V_{LCD} and the internal clock signal



- (1) The external clock signal can be applied after the generation of the V_{LCD} voltage as well.
- (2) This time depends on the external capacitor on pin V_{LCD}. For a capacitor of 100 nF a delay of 5 ms to 15 ms is expected.

Fig 7. Recommended start-up sequence when using the internal charge pump and an external clock signal

Automotive LCD driver for multiplex rates up to 1:8

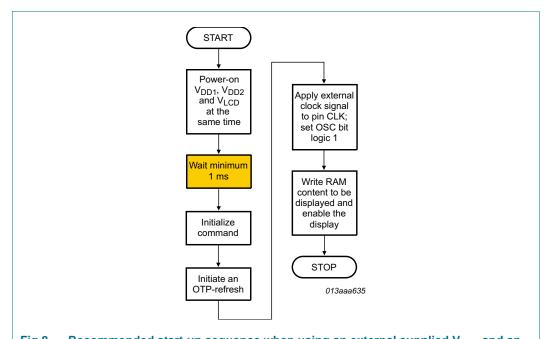
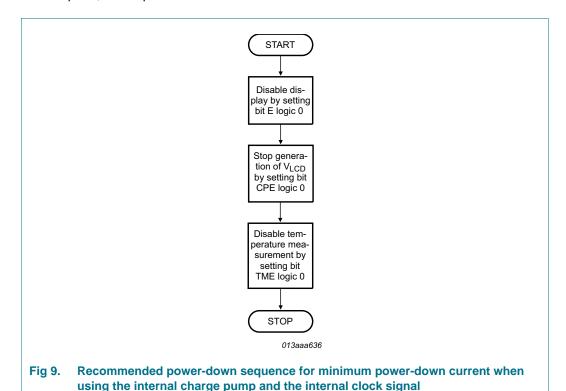


Fig 8. Recommended start-up sequence when using an external supplied V_{LCD} and an external clock signal

8.2.4 Recommended sequences to enter power-down mode

With the following sequences, the PCA8537 can be set to a state of minimum power consumption, called power-down mode.



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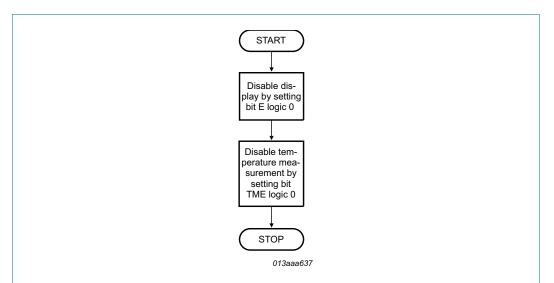


Fig 10. Recommended power-down sequence when using an external supplied V_{LCD} and the internal clock signal

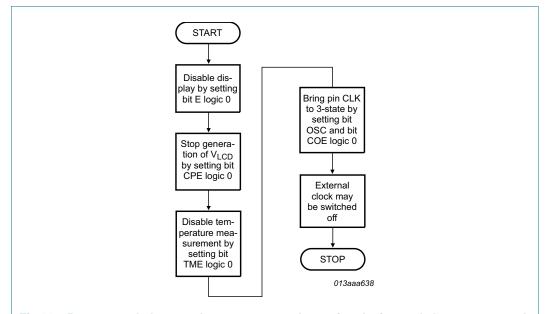
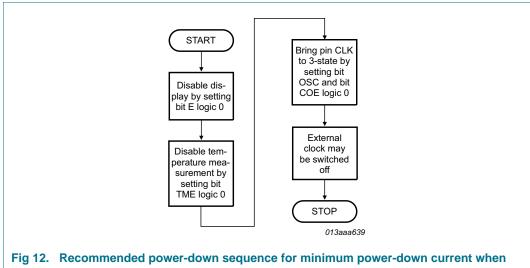


Fig 11. Recommended power-down sequence when using the internal charge pump and an external clock signal

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using an external supplied V_{LCD} and an external clock signal

Remark: It is necessary to run the power-down sequence before removing the supplies. Depending on the application, care must be taken that no other signals are present at the chip input or output pins when removing the supplies (see Section 10). Otherwise this may cause unwanted display artifacts. In the case of uncontrolled removal of supply voltages the PCA8537 will not be damaged.

Remark: Static voltages across the liquid crystal display can build up when the external LCD supply voltage (V_{LCD}) is on while the IC supply voltage (V_{DD1} or V_{DD2}) is off, or the other way around. This may cause unwanted display artifacts. To avoid such artifacts, V_{LCD}, V_{DD1}, and V_{DD2} must be applied or removed together.

Remark: A clock signal must always be supplied to the device when the display is active. Removing the clock may freeze the LCD in a DC state, which is not suitable for the liquid crystal. It is recommended to first disable the display and afterwards to remove the clock signal.

8.3 Possible display configurations

The PCA8537 is a versatile peripheral device designed to interface between any microcontroller to a wide variety of LCD segment or dot matrix displays (see Figure 13). It can directly drive any static or multiplexed LCD containing up to eight backplanes with 44 segments.

The display configurations possible with the PCA8537 depend on the number of active backplane outputs required. A selection of possible display configurations is given in Table 25.

Automotive LCD driver for multiplex rates up to 1:8

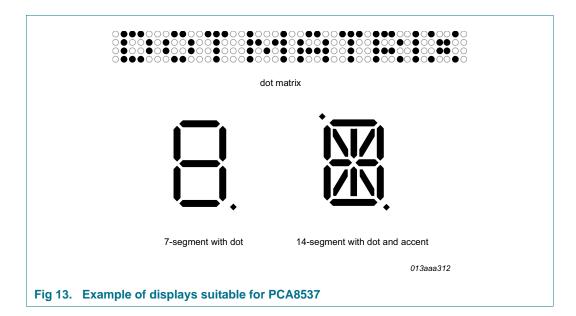
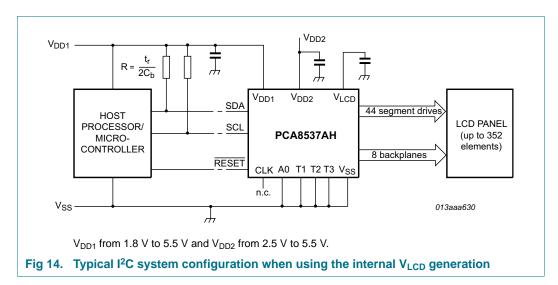


Table 25. Selection of display configurations

Number of			Digits/Charac	Digits/Characters		
Backplanes	Segments	Icons	7 segment[1]	14 segment[2]	Elements	
8	44	352	44	22	352 dots (8 × 44)	
6	46	276	34	17	276 dots (6 × 46)	
4	44	176	22	11	176 dots (4 × 44)	
2	44	88	11	5	88 dots (2 × 44)	
1	44	44	5	2	44 dots (1 × 44)	

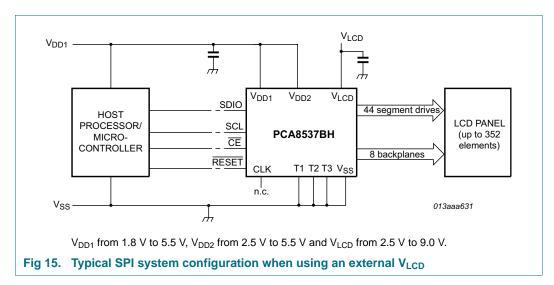
^{[1] 7} segment display has 8 elements including the decimal point.

All of the display configurations in <u>Table 25</u> can be implemented in the typical systems shown in <u>Figure 14</u> (internal V_{LCD}) and in <u>Figure 15</u> (external V_{LCD}).



^{[2] 14} segment display has 16 elements including decimal point and accent dot.

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The host microcontroller maintains the two-line I^2C -bus communication channel with the PCA8537AH or the three-line SPI-bus with the PCA8537BH. The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies (V_{DD1} , V_{DD2} , V_{SS} , V_{LCD}), the external capacitors, and the LCD panel selected for the application.

The recommended values for external capacitors on V_{DD1} , V_{DD2} , and V_{LCD} are of nominal 100 nF value. When using bigger capacitors, especially on the V_{LCD} , the generated ripple will be consequently smaller. However it will take longer for the internal charge pump to first reach the target V_{LCD} voltage.

If V_{DD1} and V_{DD2} are connected externally, the capacitors on V_{DD1} and V_{DD2} can be replaced by a single capacitor with a nominal value of 220 nF.

Remark: In case of insufficient decoupling, ripple on V_{DD1} and V_{DD2} will create additional V_{LCD} ripple. The ripple on the V_{LCD} can be reduced by making the V_{SS} connection as low-ohmic as possible. Excessive ripple on V_{LCD} may cause flicker on the display.

8.4 LCD supply voltage

8.4.1 External V_{LCD} supply

 V_{LCD} can be directly supplied to the VLCD pin. In this case, the internal charge pump must not be enabled otherwise a high current may occur on pin VDD2 and pin VLCD. When V_{LCD} is supplied externally, no internal temperature compensation occurs on this voltage even if bit TCE is set logic 1 (see Section 8.4.4.2). The V_{LCD} voltage which is supplied externally will be available at the segments and backplanes of the device through the chosen bias system. Also programming VPR[7:0] will have no effect on the V_{LCD} which is externally supplied.

8.4.2 Internal V_{LCD} generation

 V_{LCD} can be generated and controlled on the chip by using software commands. When the internal charge pump is used, the programmed V_{LCD} is available on pin VLCD. The charge pump generates a V_{LCD} of up to $3 \times V_{DD2}$. The charge pump can be enabled or disabled with the CPE bit (see <u>Table 9 on page 9</u>). With bit CPC, the charge pump multiplier setting can be configured.

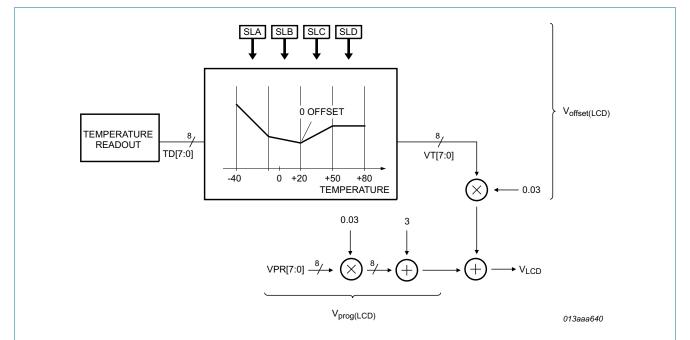
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Automotive LCD driver for multiplex rates up to 1:8

The final value of V_{LCD} is a combination of the programmed $V_{prog(LCD)}$ value and the output of the temperature compensation block, $V_{offset(LCD)}$.

$$V_{LCD} = V_{prog(LCD)} + V_{offset(LCD)}$$
 (1)

The system is shown in Figure 16.



VPR[7:0] is the binary value of the programmed voltage. VT[7:0] is the binary value of the temperature compensated voltage. Its values come from the temperature compensation block and is a two's complement which has the value 0h at 20 °C.

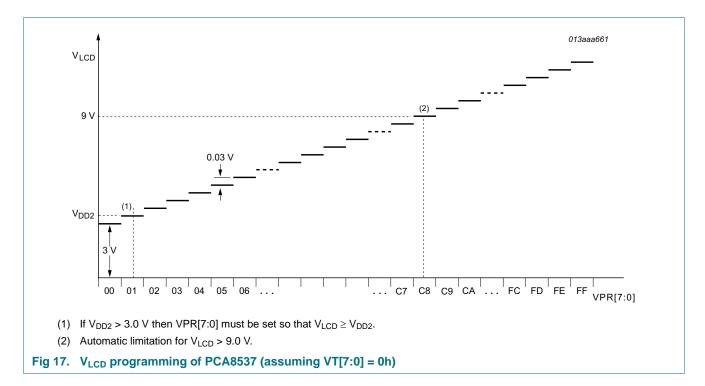
$$V_{prog(LCD)} \,=\, VPR[7:0] \times 0.03 + 3 \;. \label{eq:vprog(LCD)}$$

The equations for $V_{offset(LCD)}$, see <u>Table 28 on page 31</u>.

Fig 16. V_{LCD} generation including temperature compensation

Figure 17 illustrates how V_{LCD} changes with the programmed value of VPR[7:0].

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The programmable range of VPR[7:0] is from 0h to FFh. With the upper part of the programmable range, it is possible to achieve more than 9.0 V, but the PCA8537 has a built-in automatic limitation of V_{LCD} at 9.0 V. If V_{DD2} is higher than 3.0 V, then it is important that VPR[7:0] is set to a value such that the resultant V_{LCD} (including the temperature correction of VT[7:0]) is higher than V_{DD2} .

8.4.3 Charge pump

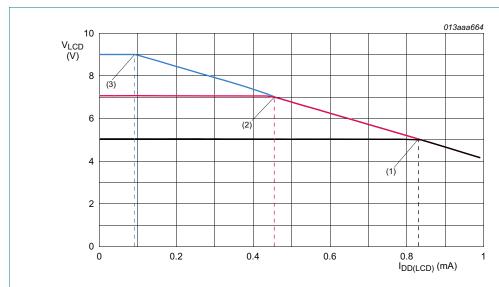
8.4.3.1 Charge pump configuration

To obtain the desired V_{LCD} values, the charge pump has to be configured properly. It has to be taken into account that the maximum theoretical values cannot be reached due to internal losses (see Section 8.4.3.2). So, for example, it is not possible to get a $V_{LCD} = 6.0 \text{ V}$ with $V_{DD2} = 3.0 \text{ V}$ and a charge pump configuration of 2 times V_{DD2} . In this case, a charge pump configuration of 3 times V_{DD2} is needed.

8.4.3.2 Charge pump driving capability

Figure 18 and Figure 19 are showing the charge pump driving capability with different settings of V_{DD2} and charge pump configurations.

Automotive LCD driver for multiplex rates up to 1:8



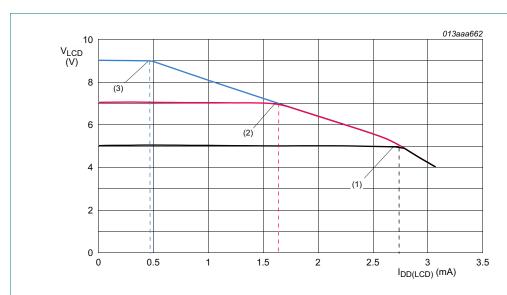
- (1) VPR[7:0] = 42h.
- (2) VPR[7:0] = 85h.
- (3) VPR[7:0] = C6h.

$$T_{amb}$$
 = 30 °C; V_{DD1} = V_{DD2} = 3.3 V.

Remark: For driving the charge pump safely the V_{LCD} and $I_{DD(LCD)}$ values have to be kept below the flat part of the respective graph.

Charge pump configuration: $V_{LCD} = 3 \times V_{DD2}$.

Fig 18. Charge pump driving capability with $V_{DD2} = 3.3 \text{ V}$



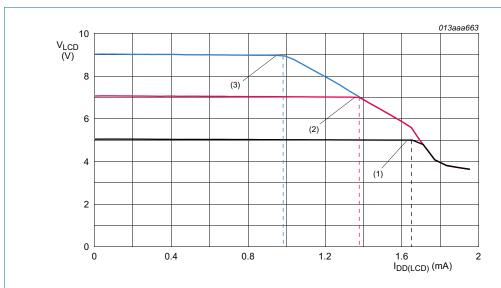
- (1) VPR[7:0] = 42h.
- (2) VPR[7:0] = 85h.
- (3) VPR[7:0] = C6h.

 $T_{amb} = 30 \, ^{\circ}C; \, V_{DD1} = V_{DD2} = 5 \, V.$

Remark: For driving the charge pump safely the V_{LCD} and $I_{DD(LCD)}$ values have to be kept below the flat part of the respective graph.

a. Charge pump configuration: $V_{LCD} = 2 \times V_{DD2}$

Automotive LCD driver for multiplex rates up to 1:8



- (1) VPR[7:0] = 42h.
- (2) VPR[7:0] = 85h.
- (3) VPR[7:0] = C6h.

 T_{amb} = 30 °C; V_{DD1} = V_{DD2} = 5 V.

Remark: For driving the charge pump safely the V_{LCD} and $I_{DD(LCD)}$ values have to be kept below the flat part of the respective graph.

b. Charge pump configuration: $V_{LCD} = 3 \times V_{DD2}$

Fig 19. Charge pump driving capability with $V_{DD2} = 5.0 \text{ V}$

8.4.4 Temperature measurement and temperature compensation of V_{LCD}

8.4.4.1 Temperature readout

The PCA8537 has a built-in temperature sensor which provides an 8 bit digital value, TD[7:0], of the ambient temperature. This value can be read through the interface (see <u>Figure 47 on page 54</u> and <u>Figure 51 on page 57</u>). The actual temperature is determined from TD[7:0] using <u>Equation 2</u>:

$$T(^{\circ}C) = 0.9375 \times TD[7:0] - 40$$
 (2)

The measurement needs about 5 ms to complete and is repeated periodically as soon as bit TME is set logic 1 (see <u>Table 10 on page 10</u>). The time between measurements is linked to the system clock and hence varies with changes in the chosen frame frequency, see <u>Table 26</u>.

Table 26. Temperature measurement update rate

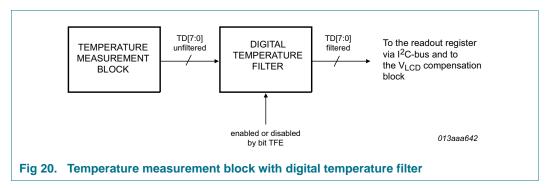
Selected frame frequency	Temperature measurement update rate			
60 Hz	3.3 s			
200 Hz	1 s			
300 Hz	0.67 s			

The temperature sensor can be thought of as analog to digital converter. Like all A/D converters, jitter will exist on the LSB of the output value. This is also true of the temperature sensor in the PCA8537. Jitter of the LSB of TD[7:0] may lead to contrast

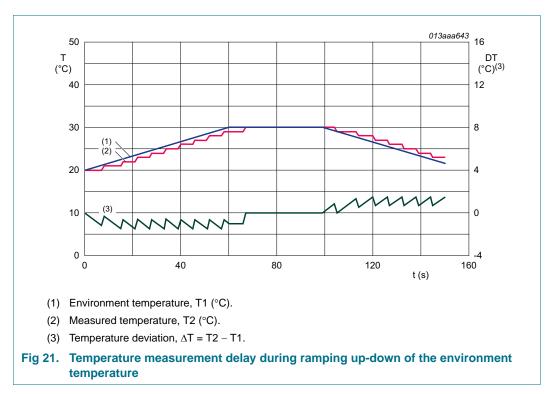
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stepping of the display due to the V_{LCD} voltage is periodically changing between two different target voltages. For this reason, a filter has been implemented to ensure that LSB jitter does not affect the display performance.



Like any other filtering, the digital temperature filter (see <u>Figure 20</u>) introduces a certain delay in the measurement of temperature. This behavior is illustrated in <u>Figure 21</u>.



This delay may cause undesired effects at start-up when the environment temperature may be different than the reset value of the PCA8537 which is 20 °C. In this case, it takes up to 30 s until the correct measured temperature value will be available. A control bit, TFE (see Table 23 on page 16), is implemented to enable or disable the digital temperature filter. This bit is set logic 0 by default, which means, that the filter is disabled and the unfiltered environment temperature value is available to calculate the desired $V_{\rm LCD}$.

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8.4.4.2 Temperature adjustment of the V_{LCD}

Due to the temperature dependency of the liquid crystal viscosity the LCD controlling voltage V_{LCD} might have to be adjusted at different temperatures to maintain optimal contrast. The temperature behavior of the liquid comes from the LCD manufacturer. The slope has to be set to compensate for the liquid behavior. Internal temperature compensation may be enabled via bit TCE (see <u>Table 10 on page 10</u>).

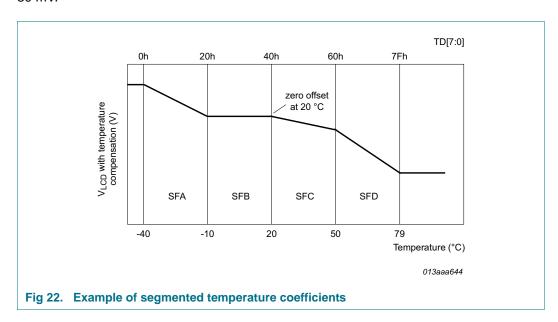
The ambient temperature range is split up into four equally sized regions and a different temperature coefficient can be applied to each. Each coefficient can be selected from a choice of eight different slopes. Each one of these coefficients may be independently selected (see Table 27).

Table 27. Temperature coefficients

SLA to SLD register value	Corresponding slope factor, SFA to SFD (mV/°C)
000[1]	0
001	-4
010	-8
011	-16
100	-40
101	+4
110	+8
111	+16

[1] Default value.

The slope factors imply a linear correction, however the implementation is in steps of 30 mV.



The offset voltage is calculated according to Table 28.

Automotive LCD driver for multiplex rates up to 1:8

Table 28. Calculation of the V_{LCD} offset voltage

Temperature range	V _{offset(LCD)} voltage (mV)
T ≤ −40 °C	$V_{offset(LCD)} = 30 \times SFA + 30 \times SFB$
-40 °C ≤ T ≤ -10 °C	$V_{offset(LCD)} = (-10 - T) \times SFA + 30 \times SFB$
-10 °C < T ≤ 20 °C	$V_{offset(LCD)} = (20 - T) \times SFB$
20 °C < T ≤ 50 °C	$V_{offset(LCD)} = (T - 20) \times SFC$
50 °C < T < 80 °C	$V_{offset(LCD)} = (T - 50) \times SFD + 30 \times SFC$
80 °C ≤ T[1]	$V_{offset(LCD)} = 30 \times SFD + 30 \times SFC$

^[1] No temperature compensation is possible above 80 °C. Above this value, the system maintains the compensation value from 80 °C.

Example: Assumed that $T_{amb} = -8 \,^{\circ}\text{C}$; SFB= $-16 \,\text{mV/}^{\circ}\text{C}$:

$$V_{offset(LCD)} = (20 - -8)x(-16) = 28 \times (-16) = -448mV$$

Remark: Care must be taken that the ranges of VPR[7:0] and VT[7:0] do not cause clipping and hence undesired results. The device will not permit overflow or underflow and will clamp results to either end of the range.

8.4.5 LCD voltage selector

The LCD voltage selector co-ordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by the Set-bias-mode command (see <u>Table 15 on page 12</u>) and the Set-MUX-mode command (see <u>Table 14 on page 12</u>).

Intermediate LCD biasing voltages are obtained from an internal voltage divider. The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of V_{LCD} and the resulting discrimination ratios (D), are given in Table 29.

Discrimination is a term which is defined as the ratio of the one and off RMS voltage across a segment. It can be thought of as a measurement of contrast.

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Table 29.	LCD drive mo	odes: summary	of o	characteristics
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LCD drive mode	Number of:		LCD bias	$V_{off(RMS)}$	$V_{on(RMS)}$	$D = \frac{V_{on(RMS)}}{1}$ [1]	V _{LCD} [2]
	Backplanes	Bias levels	configuration	$\frac{-ijj(Rinz)}{V_{LCD}}$	$\frac{-SN(RIJS)}{V_{LCD}}$	$D = \frac{Von(RMS)}{V_{off(RMS)}}$ [1]	
static	1	2	static	0	1	∞	V _{on(RMS)}
1:2 multiplex	2	3	1/2	0.354	0.791	2.236	2.828V _{off(RMS)}
1:2 multiplex	2	4	1/3	0.333	0.745	2.236	3.0V _{off(RMS)}
1:2 multiplex[3]	2	5	1/4	0.395	0.729	1.845	2.529V _{off(RMS)}
1:4 multiplex[3]	4	3	1/2	0.433	0.661	1.527	2.309V _{off(RMS)}
1:4 multiplex	4	4	1/3	0.333	0.577	1.732	3.0V _{off(RMS)}
1:4 multiplex[3]	4	5	1/4	0.331	0.545	1.646	3.024V _{off(RMS)}
1:6 multiplex[3]	6	3	1/2	0.456	0.612	1.341	2.191V _{off(RMS)}
1:6 multiplex	6	4	1/3	0.333	0.509	1.527	3.0V _{off(RMS)}
1:6 multiplex	6	5	1/4	0.306	0.467	1.527	3.266V _{off(RMS)}
1:8 multiplex[3]	8	3	1/2	0.467	0.586	1.254	2.138V _{off(RMS)}
1:8 multiplex[3]	8	4	1/3	0.333	0.471	1.414	3.0V _{off(RMS)}
1:8 multiplex	8	5	1/4	0.293	0.424	1.447	3.411V _{off(RMS)}

- [1] Determined from Equation 5.
- [2] Determined from Equation 4.
- [3] In these examples, the discrimination factor and hence the contrast ratios are smaller. The advantage of these LCD drive modes is a power saving from a reduction of the LCD voltage V_{LCD}.

A practical value for V_{LCD} is determined by equating $V_{off(RMS)}$ with a defined LCD threshold voltage (V_{th}), typically when the LCD exhibits approximately 10 % contrast. In the static drive mode, a suitable choice is $V_{LCD} > 3V_{th}$.

Bias is calculated by $\frac{1}{1+a}$, where the values for a are

a = 1 for $\frac{1}{2}$ bias

a = 2 for $\frac{1}{3}$ bias

a = 3 for $\frac{1}{4}$ bias

The RMS on-state voltage (Von(RMS)) for the LCD is calculated with Equation 3

$$V_{on(RMS)} = V_{LCD} \sqrt{\frac{a^2 + 2a + n}{n \times (1 + a)^2}}$$
 (3)

where V_{LCD} is the resultant voltage at the LCD segment and where the values for n are

n = 1 for static mode

n = 2 for 1:2 multiplex

n = 4 for 1:4 multiplex

n = 6 for 1:6 multiplex

n = 8 for 1:8 multiplex

The RMS off-state voltage (Voff(RMS)) for the LCD is calculated with Equation 4:

Automotive LCD driver for multiplex rates up to 1:8

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a^2 - 2a + n}{n \times (1 + a)^2}}$$

$$(4)$$

Discrimination is the ratio of $V_{on(RMS)}$ to $V_{off(RMS)}$ and is determined from Equation 5:

$$\frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{(a+1)^2 + (n-1)}{(a-1)^2 + (n-1)}}$$
(5)

It should be noted that V_{LCD} is sometimes referred as the LCD operating voltage.

8.4.5.1 Electro-optical performance

Suitable values for $V_{\text{on(RMS)}}$ and $V_{\text{off(RMS)}}$ are dependent on the LCD liquid used. The RMS voltage, at which a pixel will be switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at $V_{th(off)}$) and the other at 90 % relative transmission (at $V_{th(on)}$), see Figure 23. For a good contrast performance, the following rules should be followed:

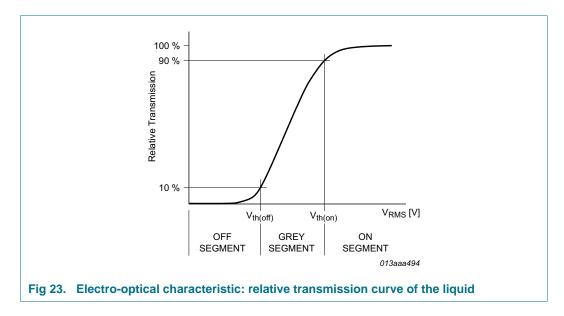
$$V_{on(RMS)} \ge V_{th(on)} \tag{6}$$

$$V_{off(RMS)} \le V_{th(off)} \tag{7}$$

 $V_{on(RMS)}$ and $V_{off(RMS)}$ are properties of the display driver and are affected by the selection of a (see <u>Equation 3</u>), n (see <u>Equation 5</u>), and the V_{LCD} voltage.

 $V_{th(off)}$ and $V_{th(on)}$ are properties of the LCD liquid and can be provided by the module manufacturer. $V_{th(off)}$ is sometimes just named V_{th} . $V_{th(on)}$ is sometimes named saturation voltage V_{sat} .

It is important to match the module properties to those of the driver in order to achieve optimum performance.

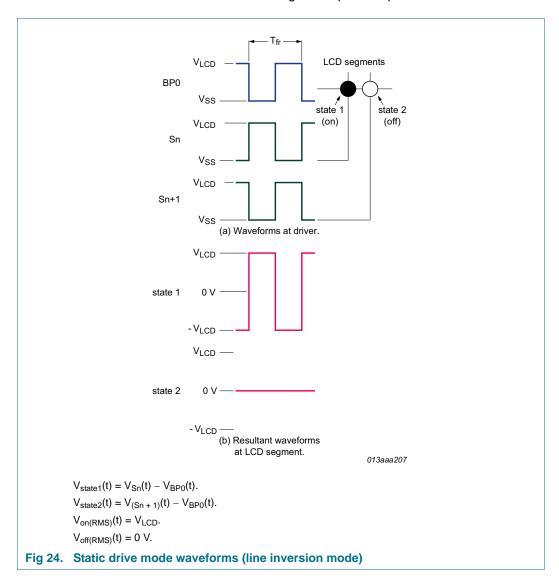


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8.4.6 LCD drive mode waveforms

8.4.6.1 Static drive mode

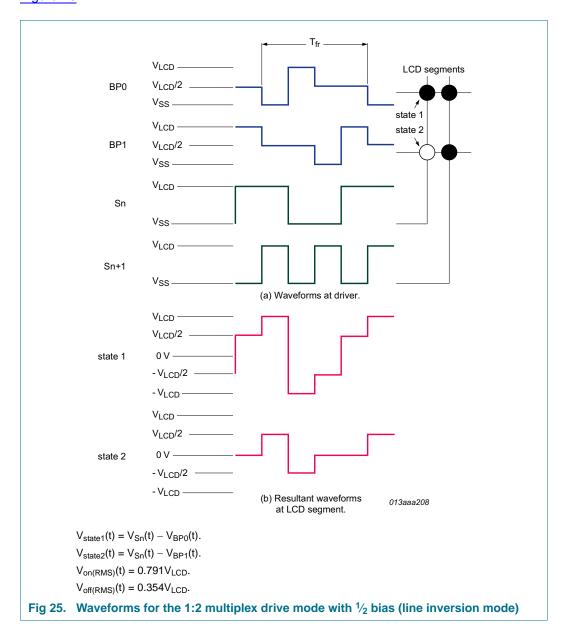
The static LCD drive mode is used when a single backplane is provided in the LCD.



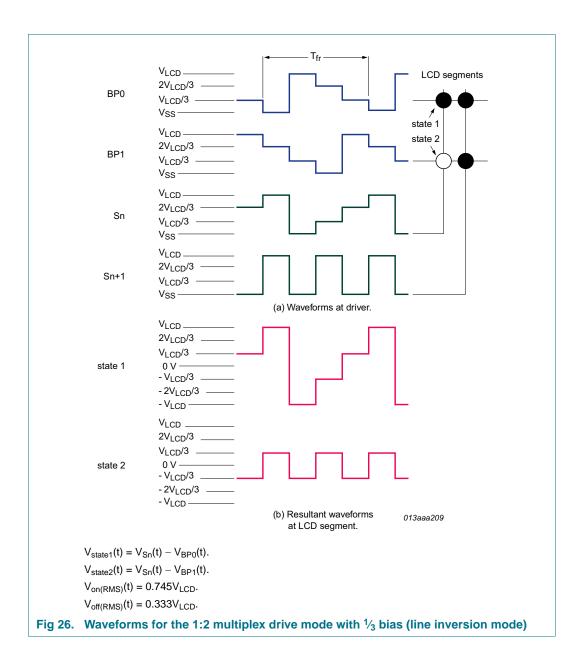
Automotive LCD driver for multiplex rates up to 1:8

8.4.6.2 1:2 multiplex drive mode

When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCA8537 allows the use of $\frac{1}{2}$ bias or $\frac{1}{3}$ bias in this mode as shown in Figure 25 and Figure 26.



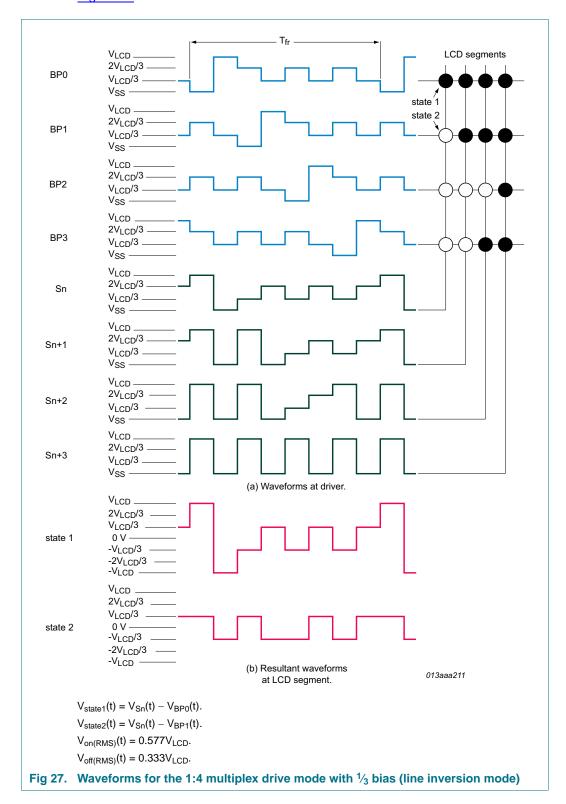
Automotive LCD driver for multiplex rates up to 1:8



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8.4.6.3 1:4 multiplex drive mode

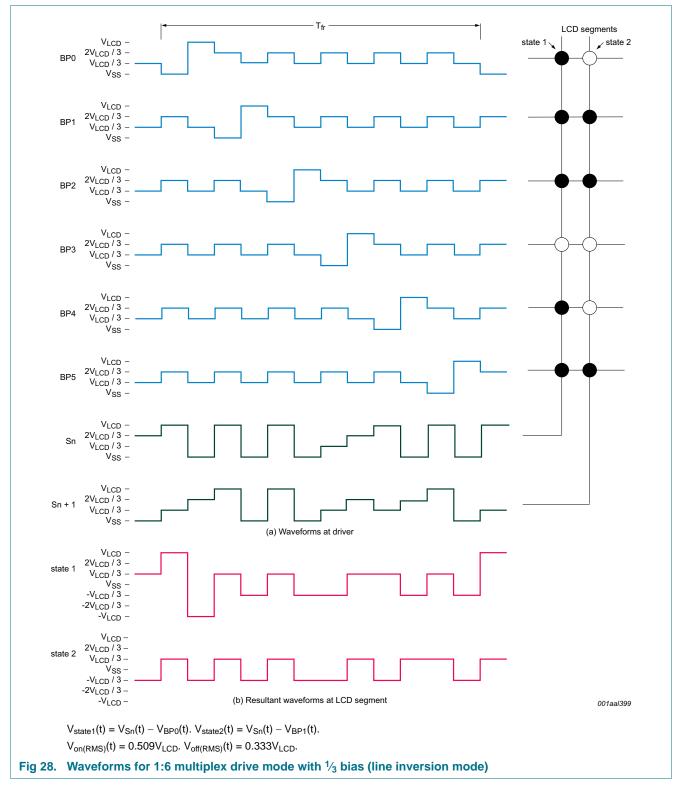
When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies, as shown in Figure 27.



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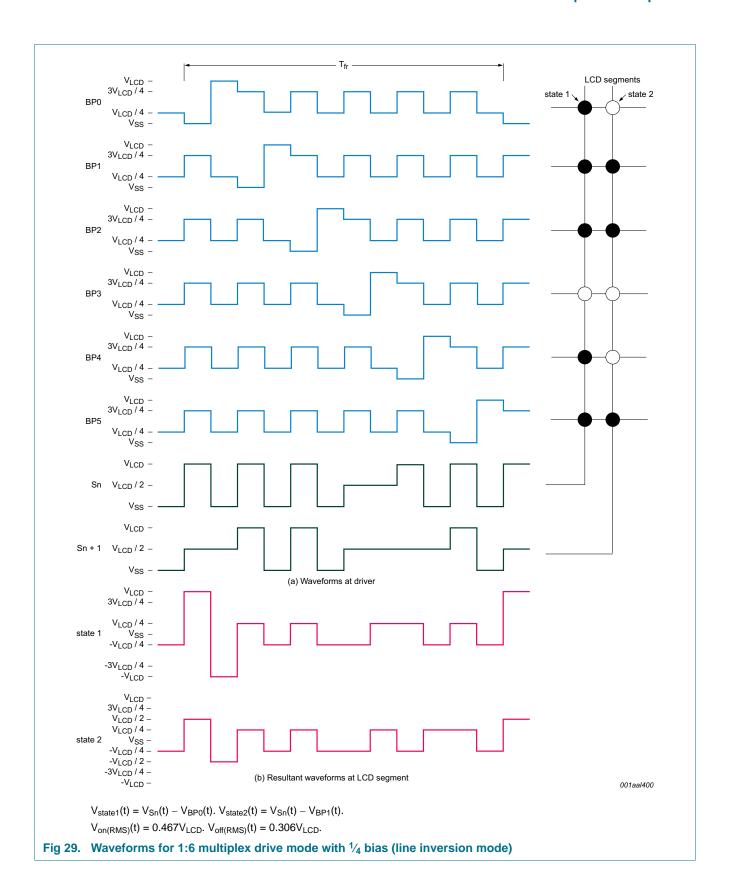
8.4.6.4 1:6 multiplex drive mode

When six backplanes are provided in the LCD, the 1:6 multiplex drive mode applies. The PCA8537 allows the use of $\frac{1}{3}$ bias or $\frac{1}{4}$ bias in this mode as shown in Figure 28 and Figure 29.



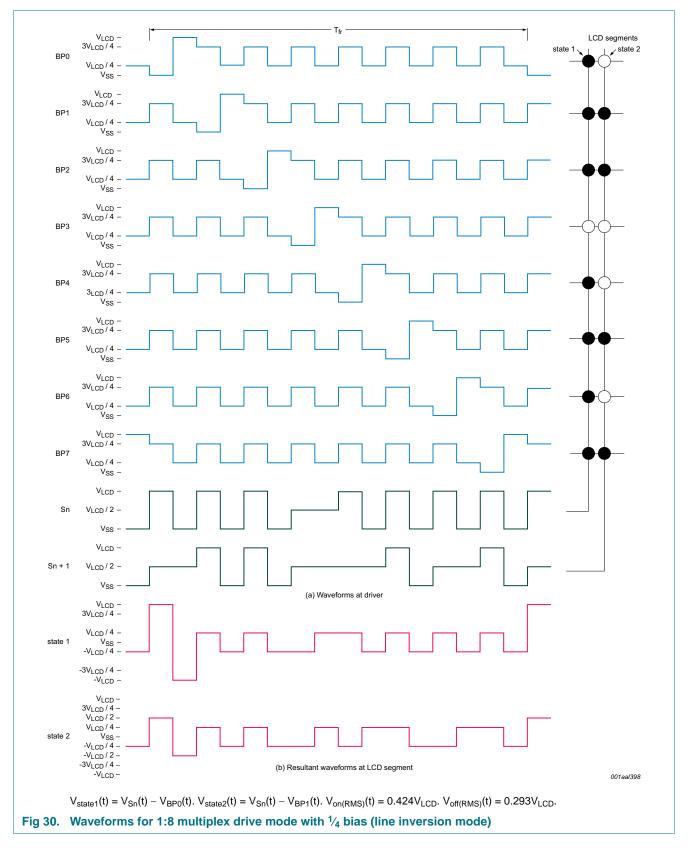
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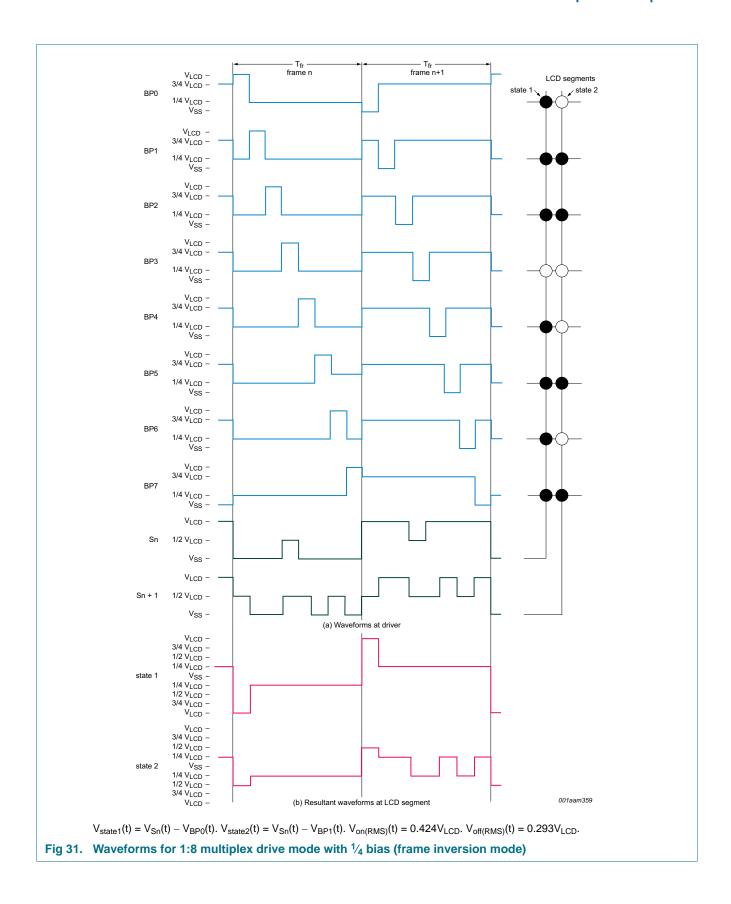


Automotive LCD driver for multiplex rates up to 1:8

8.4.6.5 1:8 multiplex drive mode



Automotive LCD driver for multiplex rates up to 1:8



Automotive LCD driver for multiplex rates up to 1:8

8.5 Backplane and segment outputs

8.5.1 Backplane outputs

The LCD drive section includes eight backplane outputs: BP0 to BP7. The backplane output signals are generated based on the selected LCD multiplex drive mode.

<u>Table 30</u> describes which outputs are active for each of the multiplex drive modes and what signal is generated.

Table 30. Mapping of output pins and corresponding signals with respect to driving mode

MUX	Output p	Output pin									
mode	BP0	BP1	BP2	BP3	BP4	BP5	S45/BP6	S44/BP7			
	Signal							•			
1:8	BP0	BP1	BP2	BP3	BP4	BP5	BP6	BP7			
1:6	BP0	BP1	BP2	BP3	BP4	BP5	S45	S44			
1:4	BP0	BP1	BP2	BP3	BP0[1]	BP1 ¹¹	BP2[1]	BP3[1]			
1:2	BP0	BP1	BP0[1]	BP1[1]	BP0[1]	BP1[1]	BP0[1]	BP1 ¹¹			
static	BP0	BP0[1]	BP0[1]	BP0[1]	BP0[1]	BP0[1]	BP0[1]	BP0[1]			

^[1] These pins may optionally or alternatively be connected to the display to improve drive strength. Connect only with the corresponding output pin carrying the same signal. If not required, they can be left open circuit.

8.5.1.1 1:8 multiplex drive mode

In 1:8 multiplex drive mode, BP0 to BP7 must be connected directly to the LCD.

8.5.1.2 1:6 multiplex drive mode

1:6 multiplex mode is a special case. In this mode BP0 to BP5 must be connected directly to the display as back plane signals and S44 and S45 must be connected to the display as segment signals.

8.5.1.3 1:4 multiplex drive mode

In the 1:4 multiplex drive mode, BP0 to BP3 must be connected directly to the LCD.

The unused BPs may be left open-circuit. Optionally they may also be connected to the display to increase drive strength.

- BP0 is repeated on BP4
- BP1 is repeated on BP5
- BP2 is repeated on BP6
- BP3 is repeated on BP7

8.5.1.4 1:2 multiplex drive mode

In the 1:2 multiplex drive mode, BP0 and BP1 must be connected directly to the LCD.

The unused BPs may be left open-circuit. Optionally they may also be connected to the display to increase drive strength.

- BP0 is repeated on BP2, BP4, and BP6
- BP1 is repeated on BP3, BP5, and BP7

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8.5.1.5 Static drive mode

In the static drive mode, BP0 must be connected directly to the LCD.

In the static drive mode, the same signal is carried by all eight backplane outputs and they can be connected in parallel for very high drive requirements.

• BP0 is repeated on BP1, BP2, BP3, BP4, BP5, BP6, and BP7

8.5.2 Segment outputs

The LCD drive section includes up to 46 segment outputs. Segments S0 to S43 are always segment outputs. There are also two more segment outputs which become active in 1:6 multiplex mode. These are S45/BP6 and S44/BP7 and must also be connected directly to the display.

The segment output signals are generated based on the multiplexed backplane signals and with data resident in the display register. When less than 46 segment outputs are required, the unused segment outputs must be left open-circuit.

8.5.2.1 Static, 1:8, 1:4, 1:2 multiplex drive mode

In these drive modes, segments S0 to S43 must be connected to the display.

8.5.2.2 1:6 multiplex drive mode

In this drive mode, segments S0 to S43, S44, and S45 must be connected to the display.

8.6 Display controller

The display controller executes the commands identified by the command decoder. It contains the status registers of the PCA8537 and co-ordinates their effects. The controller is also responsible for loading display data into the display RAM as required by the filling order.

8.7 Display register

The display register holds the display data while the corresponding multiplex signals are generated.

8.8 Display RAM

The display RAM stores LCD data. Depending on the multiplex drive mode, the arrangement of the RAM is changed.

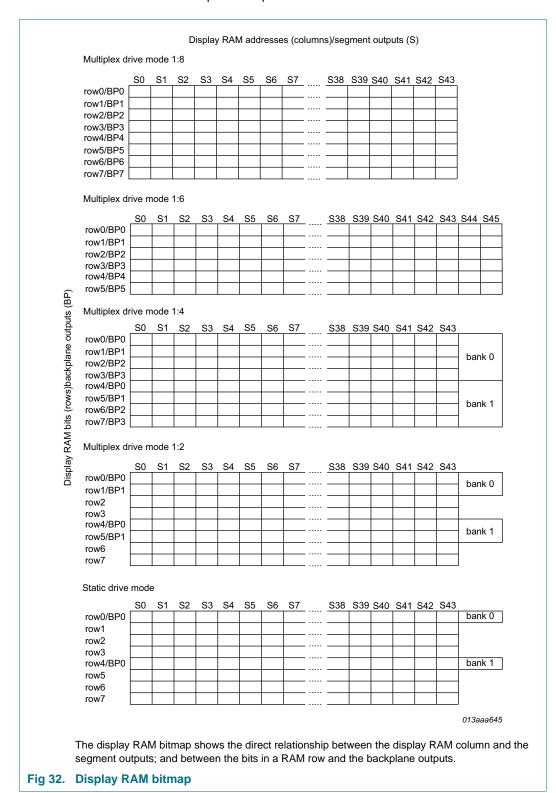
- multiplex drive mode 1:8: RAM is 44 × 8 bit
- multiplex drive mode 1:6: RAM is 46 × 6 bit
- multiplex drive mode 1:4: RAM is 44 × 4 bit arranged in two banks
- multiplex drive mode 1:2: RAM is 44 × 2 bit arranged in two banks
- static drive mode: RAM is 44 x 1 bit arranged in two banks

A logic 1 in the RAM bit map indicates the on-state of the corresponding LCD element; similarly, a logic 0 indicates the off-state.

There is a one-to-one correspondence between

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- the bits in the RAM bitmap and the LCD elements,
- the RAM columns and the segment outputs,
- the RAM rows and the backplane outputs.



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The display RAM bit map, <u>Figure 32</u>, shows row 0 to row 7 which correspond with the backplane outputs BP0 to BP7, and column 0 to column 45 which correspond with the segment outputs S0 to S45. In multiplexed LCD applications, the data of each row of the display RAM is time-multiplexed with the corresponding backplane (row 0 with BP0, row 1 with BP1, and so on).

When display data is transmitted to the PCA8537, the display bytes received are stored in the display RAM in accordance with the selected LCD multiplex drive mode. The data is stored as it arrives. Depending on the current multiplex drive mode, data is stored singularly, in pairs, quadruples, sextuples or bytes.

8.8.1 Data pointer

The addressing mechanism for the display RAM is realized using the data pointer. This allows the loading of an individual display data byte, or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialization of the data pointer by the Load-data-pointer command (see <u>Table 16 on page 12</u>).

Following this command, an arriving data byte is stored starting at the display RAM address indicated by the data pointer.

After each byte stored, the data pointer is automatically incremented in accordance with the chosen LCD multiplex drive mode configuration:

- by eight (static drive mode)
- by four (1:2 multiplex drive mode)
- by two (1:4 multiplex drive mode)
- by one or two (1:6 multiplex drive mode), see Figure 37 on page 48
- by one (1:8 multiplex drive mode)

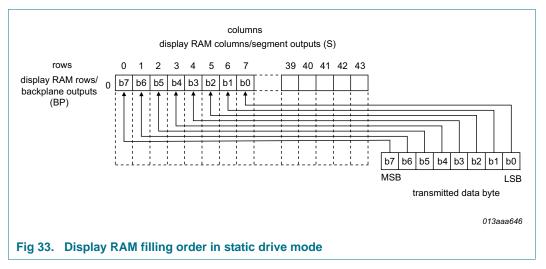
When the address counter reaches the end of the RAM row, it stops incrementing after the last byte is transmitted. Redundant bits of the last byte transmitted are discarded. Additional bytes, sent after the end of the RAM is reached, will be discarded too. The data pointer does not wrap around to the beginning. To send new RAM data, the data pointer must be reset.

If an I²C-bus or SPI-bus data access is terminated early, then the state of the data pointer is unknown. The data pointer must then be re-written before further RAM accesses.

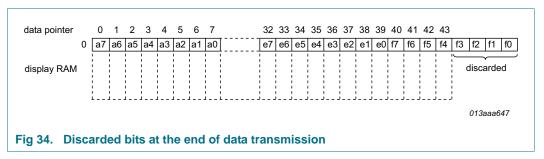
8.8.2 RAM filling in static drive mode

In the static drive mode the eight transmitted data bits are placed in eight successive display RAM columns in row 0 (see Figure 33).

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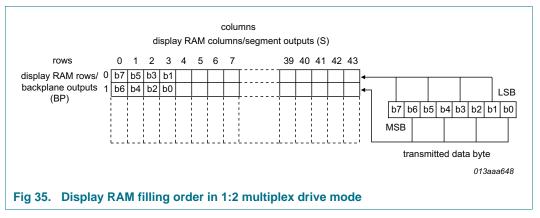
In order to fill the whole RAM row, 6 bytes must be sent to the PCA8537, but the last 4 bits from the last byte are discarded (see Figure 34).



When bit IBS is set to bank 1 (see Table 19 on page 14), then data is stored in row 4.

8.8.3 RAM filling in 1:2 multiplex drive mode

In the 1:2 multiplex drive mode the eight transmitted data bits are placed in four successive display RAM columns (see <u>Figure 35</u>). In order to fill the whole two RAM rows 11 bytes need to be sent to the PCA8537.

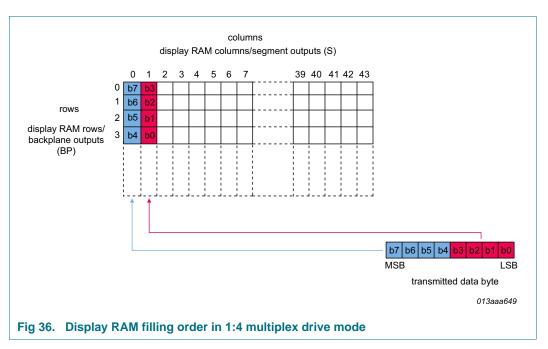


When bit IBS is set to bank 1 (see <u>Table 19 on page 14</u>), then data is stored in row 4 and row 5.

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8.8.4 RAM filling in 1:4 multiplex drive mode

In the 1:4 multiplex drive mode the eight transmitted data bits are placed in two successive display RAM columns of four rows (see <u>Figure 36</u>). In order to fill the whole four RAM rows 22 bytes need to be sent to the PCA8537.

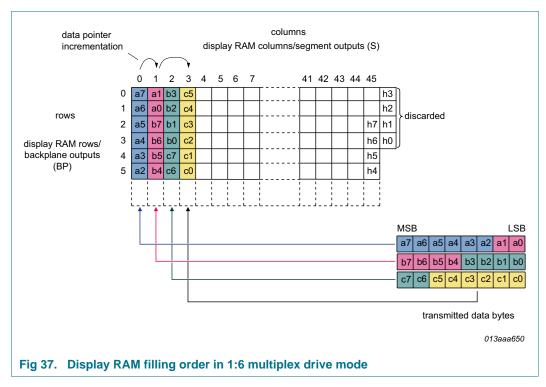


When bit IBS is set to bank 1 (see <u>Table 19 on page 14</u>), then data is stored in rows 4 to row 7.

8.8.5 RAM filling in 1:6 multiplex drive mode

In the 1:6 multiplex drive mode the RAM is organized in six rows and 46 columns. The eight transmitted data bits are placed in such a way, that a column is filled up (see Figure 37). The remaining bits are wrapped up into the next column. In order to fill the whole RAM addresses 35 bytes need to be sent to the PCA8537, however the four least significant bits of the 35th byte are discarded.

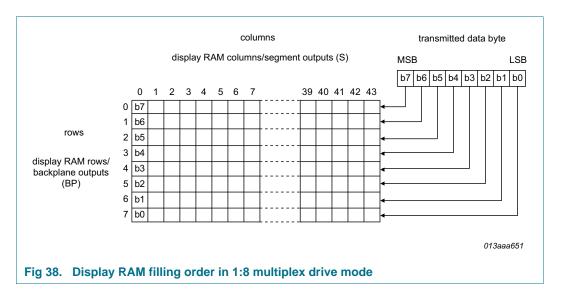
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When data transfer is initiated, then the MSB of the first byte will always be placed in row 0. Data must be transferred contiguously to achieve RAM filling as described in Figure 37.

8.8.6 RAM filling in 1:8 multiplex drive mode

In the 1:8 multiplex drive mode the eight transmitted data bits are placed into eight rows of one display RAM column (see <u>Figure 38</u>). In order to fill the whole RAM addresses 44 bytes need to be sent to the PCA8537.

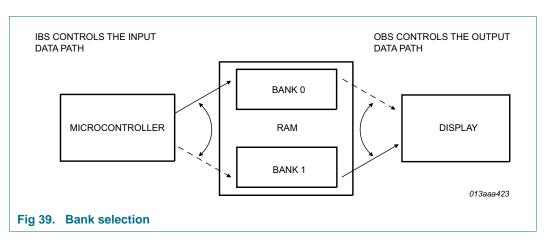


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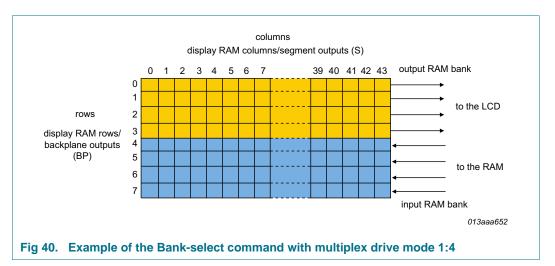
8.9 Bank selection

The PCA8537 includes a RAM bank switching feature in the static, 1:2, and 1:4 multiplex drive modes. A bank can be thought of as a collection of RAM rows. The RAM bank switching gives the provision for preparing display information in an alternative bank and to be able to switch to it once it is complete.

There are two banks; bank 0 and bank 1. <u>Figure 32 on page 44</u> shows the location of these banks relative to the RAM map. Input and output banks can be set independently from one another with the Bank-select command (see <u>Table 19 on page 14</u>). <u>Figure 39</u> shows the concept.



In <u>Figure 40</u> an example is shown for 1:4 multiplex drive mode where the displayed data is read from the first four rows of the memory (bank 0), while the transmitted data is stored in the second four rows of the memory (bank 1).



8.9.1 Input bank selection

The IBS (input bank selection) bit of the Bank-select command (see <u>Table 19</u>) controls where display data is loaded into the display RAM.

The input bank selection works independently of output bank selection.

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8.9.2 Output bank selection

The OBS bit of the Bank-select command (see <u>Table 19 on page 14</u>) controls from which bank display data is taken,

The output bank selection works independently of input bank selection.

9. Bus interfaces

9.1 Control byte

After initiating the communication over the bus and sending the slave address (I²C-bus, see <u>Section 9.2</u>) or subaddress (SPI-bus, see <u>Section 9.3</u>), a control byte follows. The purpose of this byte is to indicate both, the content for the following data bytes (RAM or command) and to indicate that more control bytes will follow.

Typical sequences could be:

- Slave address/subaddress control byte command byte command byte command byte end
- Slave address/subaddress control byte RAM byte RAM byte RAM byte end
- Slave address/subaddress control byte command byte control byte RAM byte end

In this way, it is possible to send a mixture of RAM and command data in one access or alternatively, to send just one type of data in one access.

Table 31. Control byte description

Bit	Symbol	Binary value	Description
7	CO		continue bit
		0	last control byte
		1 control bytes continue	
6	RS		register selection
		0	command register
		1	data register
5 to 0	-		not relevant

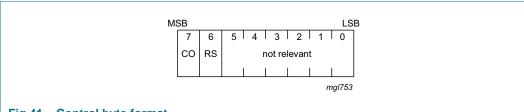


Fig 41. Control byte format

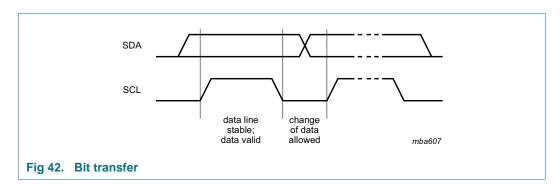
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9.2 I²C-bus interface characteristics (PCA8537AH)

The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

9.2.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see <u>Figure 42</u>).



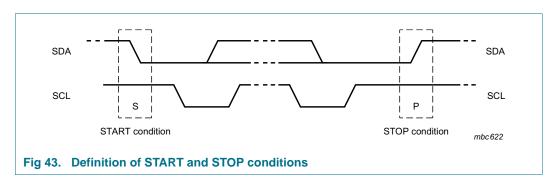
9.2.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.

A HIGH-to-LOW change of the data line, while the clock is HIGH is defined as the START condition (S).

A LOW-to-HIGH change of the data line while the clock is HIGH is defined as the STOP condition (P).

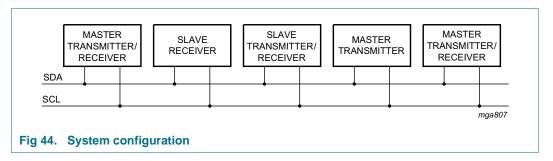
The START and STOP conditions are shown in Figure 43.



9.2.3 System configuration

A device generating a message is a transmitter, a device receiving a message is the receiver. The device that controls the message is the master and the devices which are controlled by the master are the slaves. The system configuration is shown in Figure 44.

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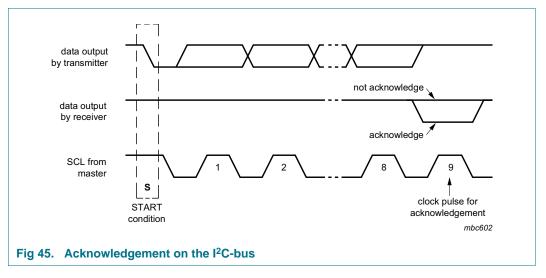


9.2.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of 8 bits is followed by an acknowledge cycle.

- A slave receiver which is addressed must generate an acknowledge after the reception of each byte.
- Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be considered).
- A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

Acknowledgement on the I²C-bus is shown in Figure 45.



9.2.5 I²C-bus controller

The PCA8537AH acts as an I²C-bus slave receiver. It does not initiate I²C-bus transfers or transmit data to an I²C-bus master receiver. The only data output from PCA8537AH are the acknowledge signals and the temperature readout byte of the selected device.

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9.2.6 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

9.2.7 I²C-bus slave address

The device selection depends on the I²C-bus slave address.

Two different I²C-bus slave addresses can be used to address the PCA8537AH (see Table 32).

Table 32. I²C slave address byte

	Slave ad	dress						
Bit	7	6	5	4	3	2	1	0
	MSB							LSB
	0	1	1	1	0	0	A0	R/W

Bit 1 of the slave address is defined by connecting the input A0 to either V_{SS} (logic 0) or V_{DD} (logic 1). Therefore, two instances of PCA8537AH can be distinguished on the same I^2C -bus.

The least significant bit of the slave address byte is bit R/\overline{W} (see Table 33).

Table 33. R/W bit description

Symbol	Value	Description
R/W		data read or write selection
	0	write data
	1	read data[1]

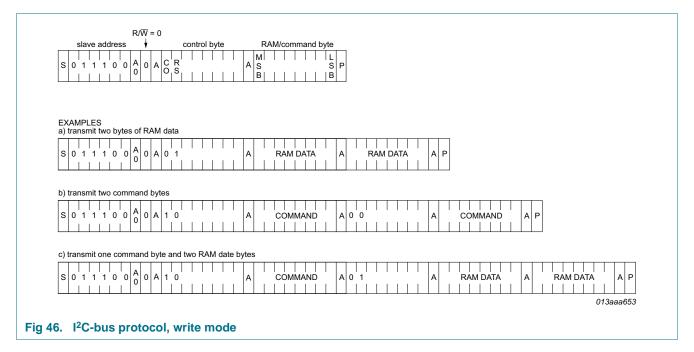
^[1] Only used for temperature readout from PCA8537AH (see <u>Table 21 on page 15</u>).

9.2.8 I²C-bus protocol

The I²C-bus protocol is shown in <u>Figure 46</u>. The sequence is initiated with a START condition (S) from the I²C-bus master which is followed by one of the two PCA8537AH slave addresses available. All PCA8537AH's with the corresponding A0 level acknowledge in parallel to the slave address, but all PCA8537AH with an alternative A0 level ignore the whole I²C-bus transfer.

After acknowledgement, a control byte follows (see Section 9.1 on page 50).

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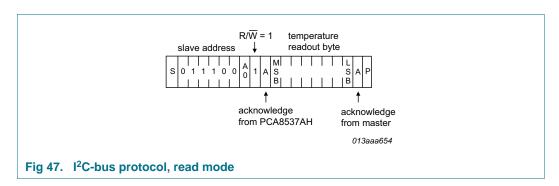


The display bytes are stored in the display RAM at the address specified by the data pointer.

The acknowledgement after each byte is made only by the addressed PCA8537AH. After the last display byte, the I²C-bus master issues a STOP condition (P). Alternatively a START may be issued to RESTART an I²C-bus access.

9.2.9 Data read

If a temperature readout (byte TD[7:0]) is made, the R/W bit must be logic 1 and then the next data byte following is provided by the PCA8537AH as shown in Figure 47.



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9.3 SPI-bus interface (PCA8537BH)

Data transfer to the device is made $\underline{\text{via}}$ a three-line SPI-bus (see $\underline{\text{Table 31}}$). The SPI-bus is reset whenever the chip enable pin $\overline{\text{CE}}$ is inactive.

Table 34. Serial interface

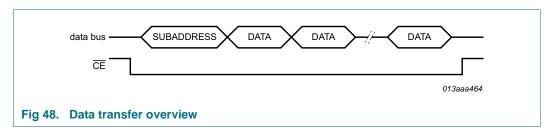
Pin	Function	Description
CE	chip enable input; active LOW[1]	when HIGH, the interface is reset;
SCL	serial clock input	-
SDIO	serial data input output	input data is sampled on the rising edge of SCL;
		data is output on the falling edge of SCL

^[1] The chip enable must not be wired permanently LOW.

9.3.1 Data transmission

The chip enable signal is used to identify the transmitted data. Each data transfer is a byte, with the Most Significant Bit (MSB) sent first.

The transmission is controlled by the active LOW chip enable signal $\overline{\text{CE}}$. The first byte transmitted is the subaddress byte.



The subaddress byte opens the communication with a read/write bit and a subaddress. The subaddress is used to identify multiple devices on one SPI-bus.

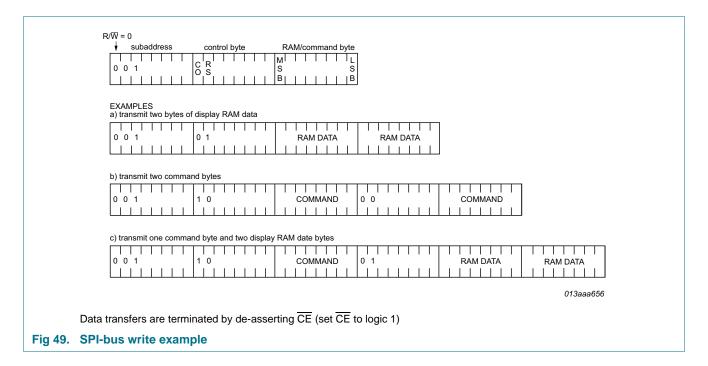
Table 35. Subaddress byte definition

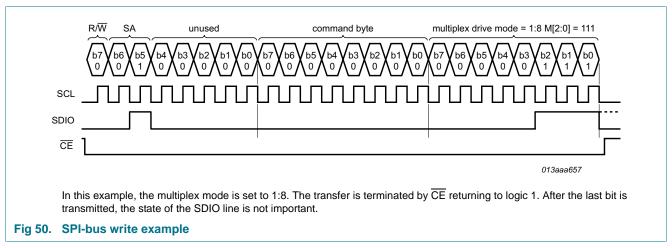
Bit	Symbol	Binary value	Description
7	R/W		data read or write selection
		0	write data
		1	read data[1]
6 to 5	SA[1:0]	01	subaddress ; other codes will cause the device to ignore data transfer
4 to 0	-	-	unused

[1] Only used for temperature readout from PCA8537BH (see <u>Table 21 on page 15</u>).

After the subaddress byte, a control byte follows (see Section 9.1 on page 50).

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9.3.2 Data read

The temperature readout data byte TD[7:0] can be read from the PCA8537BH.

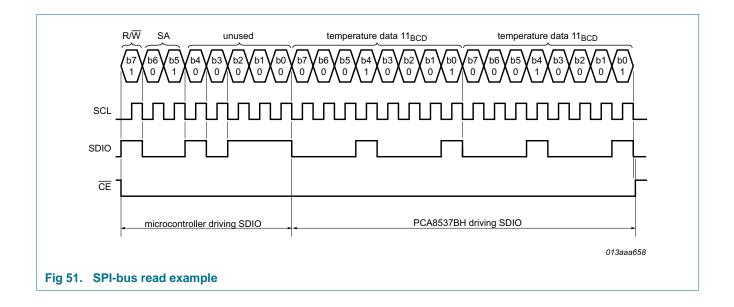
A readout is initiated by sending the subaddress byte with the R/\overline{W} bit set high. The transmission is controlled by the active LOW chip enable signal \overline{CE} .

After the last bit of the subaddress byte is transmitted, the PCA8537BH will immediately start to drive the SDIO line. It is only necessary to read the values once, however since the update of the register is asynchronous to the interface clock, it is recommended to read the register twice and check for a stable value.

The readout is terminated by asserting $\overline{\text{CE}}$. At this time, the SDIO bus is released. It is important that the bus is not left floating and that the microcontroller then takes over driving of the bus.

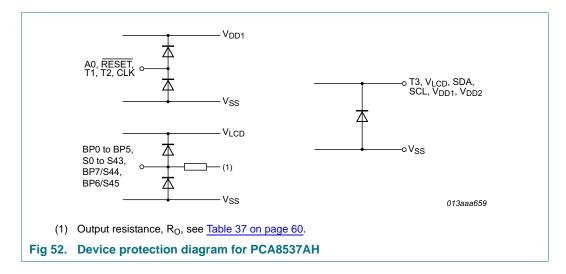
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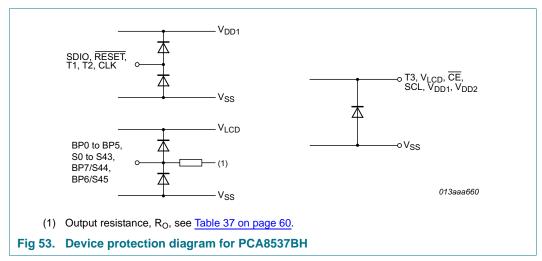
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10. Internal circuitry





11. Safety notes

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

CAUTION



Static voltages across the liquid crystal display can build up when the LCD supply voltage (V_{LCD}) is on while the IC supply voltage (V_{DD}) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts, V_{LCD} and V_{DD} must be applied or removed together.

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12. Limiting values

Table 36. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD1}	supply voltage 1	digital	-0.5	+6.5	V
V_{DD2}	supply voltage 2	analog	-0.5	+6.5	V
I _{DD1}	supply current 1	digital	-50	+50	mA
I _{DD2}	supply current 2	analog	-50	+50	mA
V_{LCD}	LCD supply voltage		-0.5	+10	V
I _{DD(LCD)}	LCD supply current		-50	+50	mA
Vi	input voltage	on pins CLK, CE, SDA, SCL, A0, SDIO, T1, T2	-0.5	+6.5	V
I _I	input current		-10	+10	mA
Vo	output voltage	on pins S0 to S45, BP0 to BP7	-0.5	+10	V
		on pins SDA, SDIO, CLK	-0.5	+6.5	V
Io	output current		-10	+10	mA
I _{SS}	ground supply current		-50	+50	mA
P _{tot}	total power dissipation		-	400	mW
P/out	power dissipation per output		-	100	mW
V _{ESD}	electrostatic discharge	HBM [1]	-	±4500	V
	voltage	CDM [2]	-	±1500	V
I _{lu}	latch-up current	[3]	-	200	mA
T _{stg}	storage temperature	[4]	-65	+150	°C
T _{amb}	ambient temperature	operating device	-40	+95	°C

^[1] Pass level; Human Body Model (HBM), according to Ref. 6 "JESD22-A114".

^[2] Pass level; Charged-Device Model (CDM), according to Ref. 7 "JESD22-C101".

^[3] Pass level; latch-up testing according to Ref. 8 "JESD78" at maximum ambient temperature (T_{amb(max)}).

^[4] According to the NXP store and transport requirements (see Ref. 10 "NX3-00092") the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %. For long term storage products deviant conditions are described in that document.

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13. Static characteristics

Table 37. Static characteristics

 V_{DD1} = 1.8 V to 5.5 V; V_{DD2} = 2.5 V to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 V to 9.0 V; T_{amb} = -40 °C to +95 °C; temperature measurement enabled; 1:8 multiplex drive mode; 1/4 bias; LCD outputs are open circuit; RAM is all written with logic 1; inputs at V_{SS} or V_{DD} ; internal clock with maximum prescale factor; PC-bus/SPI-bus inactive; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supplies	'					
V_{DD1}	supply voltage 1	logic	1.8	-	5.5	V
V_{DD2}	supply voltage 2	analog; $V_{DD2} \geq V_{DD1}$				
		charge pump set to 2 × V _{DD2}	2.5	-	5.5	V
		charge pump set to $3 \times V_{DD2}$	2.5	-	5.5	V
V_{LCD}	LCD supply voltage	$V_{LCD} \ge V_{DD2}$ [1]	2.5	-	9.0	V
ΔV_{LCD}	LCD voltage variation	$V_{DD1} = V_{DD2} = 5.0 \text{ V};$ [2] $V_{LCD} = 6.99 \text{ V}$	-0.10	-	+0.10	V
I _{DD1}	supply current 1	digital; display disabled; charge pump off	-	90	200	μА
I _{DD2}	supply current 2	display disabled; charge pump off; external V _{LCD}	-	0.5	-	μА
		V_{DD2} = 5.5 V; charge pump set to 2 × V_{DD2} ; internal V_{LCD} = 7.0 V				
		display disabled	-	30	40	μΑ
		display enabled [3]	-	200	-	μΑ
I _{DD(LCD)}	LCD supply current	external V _{LCD} = 7.0 V; display enabled;	-	85	-	μА
I _{DD(pd)}	power-down mode supply current	on pin V _{DD1}	-	1	3	μА
I _{LCD(pd)}	power-down LCD current		-	15	25	μΑ
T _{acc}	temperature accuracy	readout temperature error; V _{DD1} = 5.0 V				
		$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +95 ^{\circ}\text{C}$	-5	-	+5	°C
		T _{amb} = 25 °C	-3	-	+3	°C
Logic						
V_{I}	input voltage		$V_{SS}-0.5$	-	$V_{DD} + 0.5$	V
V_{IL}	LOW-level input voltage	on pins CLK and A0	-	-	$0.3V_{DD}$	V
V_{IH}	HIGH-level input voltage	on pins CLK and A0	$0.7V_{DD}$	-	-	V
Vo	output voltage		-0.5	-	V _{DD} + 0.5	V
V _{OH}	HIGH-level output voltage	on pin CLK	$0.8V_{DD}$	-	-	V
V _{OL}	LOW-level output voltage	on pin CLK	-	-	0.2V _{DD}	V
I _{OH}	HIGH-level output current	output source current; $V_{OH} = 4.6 \text{ V};$ $V_{DD} = 5 \text{ V};$ on pin CLK	1	-	-	mA

Automotive LCD driver for multiplex rates up to 1:8

Table 37. Static characteristics ... continued

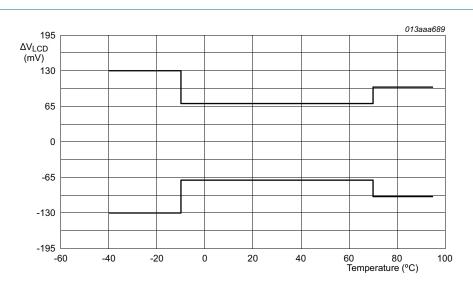
 V_{DD1} = 1.8 V to 5.5 V; V_{DD2} = 2.5 V to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 V to 9.0 V; T_{amb} = -40 °C to +95 °C; temperature measurement enabled; 1:8 multiplex drive mode; ${}^{1}\!/_{4}$ bias; LCD outputs are open circuit; RAM is all written with logic 1; inputs at V_{SS} or V_{DD} ; internal clock with maximum prescale factor; ${}^{2}\!/_{2}$ C-bus/SPI-bus inactive; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{OL}	LOW-level output current	output sink current; $V_{OL} = 0.4 \text{ V};$ $V_{DD} = 5 \text{ V};$ on pin CLK	1	-	-	mA
V _{POR}	power-on reset voltage	[4]	-	-	1.6	V
IL	leakage current	$V_i = V_{DD}$ or V_{SS} ; on pins CLK and A0	-1	-	+1	μΑ
I ² C- and SF	Pl-bus lines; pins SDA, SCL	and SDIO			·	
VI	input voltage					
		pins SDA, SCL	$V_{SS}-0.5$	-	5.5	V
		pin SDIO	$V_{SS}-0.5$	-	V _{DD} + 0.5	V
V _{IL}	LOW-level input voltage	pins SDA, SCL, and SDIO	-	-	0.3V _{DD}	V
V _{IH}	HIGH-level input voltage	pins SDA, SCL, and SDIO	0.7V _{DD}	-	-	V
Vo	output voltage					
		pins SDA and SCL	-0.5	-	5.5	V
		SDIO	-0.5	-	V _{DD} + 0.5	V
I _{OL}	LOW-level output current	$V_{OL} = 0.4 \text{ V};$ $V_{DD} = 5 \text{ V};$ on pin SDA and SDIO	3	-	-	mA
I _{OH}	HIGH-level output current	$V_{OH} = 4.6 \text{ V};$ $V_{DD} = 5 \text{ V};$ on pin SDIO	3	-	-	mA
IL	leakage current	$V_I = V_{DD}$ or V_{SS}	-1	-	+1	μΑ
LCD outpu	ts		'		1	
ΔV_{O}	output voltage variation	on pins BP0 to BP7 [5]	-15	-	+15	mV
		on pins S0 to S45	-15	-	+15	mV
R _O	output resistance	V _{LCD} = 7 V; [7] on pins BP0 to BP7	0.3	0.8	1.5	kΩ
		V _{LCD} = 7 V; [7] on pins S0 to S45	0.6	1.5	3	kΩ

^[1] When supplying external V_{LCD} it must be $V_{LCD} \ge V_{DD2}$. Also when using the internal charge pump to generate a certain V_{LCD} , VPR[7:0] must be set to a value that the voltage is higher than V_{DD2} (see Section 8.4.2).

- [2] Calibrated at testing stage. V_{LCD} temperature compensation is disabled.
- [3] Tested on sample basis.
- [4] If $V_{DD1} < V_{POR}$ a reset occurs.
- [5] Variation between any 2 backplanes on a given voltage level; static measured.
- [6] Variation between any 2 segments on a given voltage level; static measured.
- [7] Outputs measured one at a time.

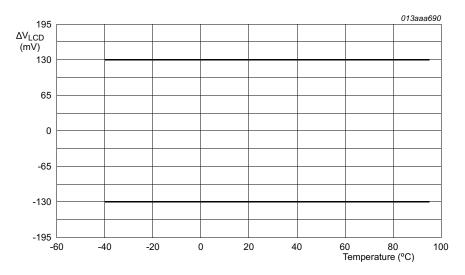
Automotive LCD driver for multiplex rates up to 1:8



 $V_{LCD} = 5 V to 9 V.$

Remark: Only valid if the charge pump is driven in a safe range as described in <u>Figure 18</u> and <u>Figure 19</u>.

a. $V_{DD} = 5 V$



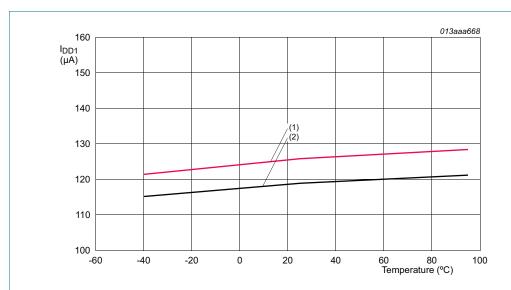
 $V_{LCD} = 5 V \text{ to } 9 V.$

Remark: Only valid if the charge pump is driven in a safe range as described in $\frac{\text{Figure 18}}{\text{Figure 19}}$ and $\frac{\text{Figure 19}}{\text{Figure 19}}$.

b. $V_{DD} = 3 V$

Fig 54. LCD voltage variation with respect to temperature

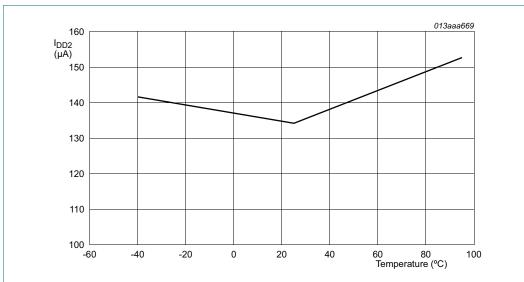
Automotive LCD driver for multiplex rates up to 1:8



 V_{DD2} = 5.0 V; 1:8 multiplex drive mode; \mathcal{V}_4 bias; temperature measurement enabled; LCD outputs are open circuit; RAM all logic 1; inputs at V_{SS} or V_{DD} ; internal clock with max prescale factor; bus active.

- (1) Charge pump on; V_{DD1} = 5.5 V; charge pump configuration: V_{LCD} = 2 × V_{DD2} ; VPR[7:0] set to 7.0 V; display enabled.
- (2) Charge pump off; $V_{DD1} = 5.0 \text{ V}$; display disabled.

Fig 55. Typical I_{DD1} with respect to temperature



 $V_{DD1} = V_{DD2} = 5.0 \text{ V}$; 1:8 multiplex drive mode; ${}^{1}\!\!/_{4}$ bias; temperature measurement enabled; flat temperature compensation; LCD outputs are open circuit; RAM all logic 1; inputs at V_{SS} or V_{DD} ; internal clock with max prescale factor; bus inactive; charge pump on; charge pump configuration: $V_{LCD} = 2 \times V_{DD2}$; VPR[7:0] set to 7.0 V; display enabled.

Fig 56. Typical I_{DD2} with respect to temperature

Automotive LCD driver for multiplex rates up to 1:8

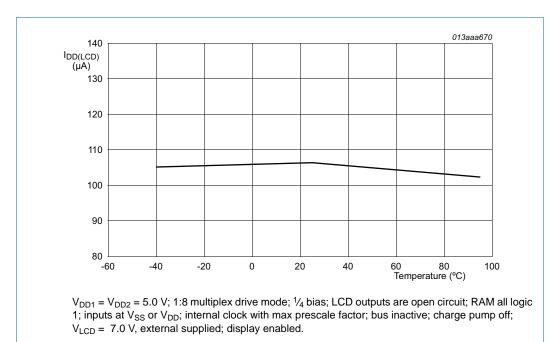


Fig 57. Typical I_{DD(LCD)} with respect to temperature

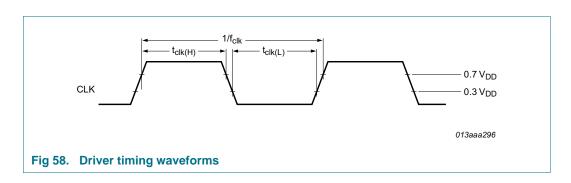
14. Dynamic characteristics

Table 38. Dynamic characteristics

 V_{DD} = 1.8 V to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 V to 9.0 V; T_{amb} = -40 °C to +95 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f _{clk(ext)}	external clock frequency			450	-	14500	Hz
t _{clk(H)}	clock HIGH time	external clock source used		33	-	-	μS
t _{clk(L)}	clock LOW time			33	-	-	μS
f _{clk}	clock frequency	on pin CLK; see <u>Table 18</u>	[1]	7800	9600	11 040	Hz
t _{w(rst)L}	LOW-level reset time			400	-	-	ns

[1] Frequency present on OSCCLK with default display frequency division factor.



Automotive LCD driver for multiplex rates up to 1:8

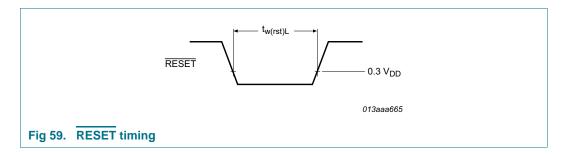


Table 39. Timing characteristics: I²C-bus

 V_{DD1} = 1.8 V to 5.5 V; V_{DD2} = 2.5 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +95 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{SCL}	SCL clock frequency		-	-	400	kHz
t _{BUF}	bus free time between a STOP and START condition		1.3	-	-	μS
t _{HD;STA}	hold time (repeated) START condition		0.6	-	-	μS
t _{SU;STA}	set-up time for a repeated START condition		0.6	-	-	μS
t _{VD;DAT}	data valid time	[4]	-	-	0.9	μS
t _{VD;ACK}	data valid acknowledge time	[5]	-	-	0.9	μS
t _{LOW}	LOW period of the SCL clock		1.3	-	-	μS
t _{HIGH}	HIGH period of the SCL clock		0.6	-	-	μS
t _f	fall time	of both SDA and SCL signals	-	-	0.3	μS
t _r	rise time	of both SDA and SCL signals	-	-	0.3	μS
C _b	capacitive load for each bus line		-	-	400	pF
t _{SU;DAT}	data set-up time		100	-	-	ns
t _{HD;DAT}	data hold time		0	-	-	ns
t _{SU;STO}	set-up time for STOP condition		0.6	-	-	μS
t _{w(spike)}	spike pulse width		-	-	50	ns

^[1] Internal calibration made with OTP so that the maximum variation is ±15 % over whole temperature and voltage range. The typical f_{clk} frequency generates a typical frame frequency of 200 Hz when the default frequency division factor is used.

^[2] The typical value is defined at V_{DD1} = V_{DD2} = 5.0 V and 30 °C.

^[3] All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .

^[4] $t_{VD;DAT}$ = minimum time for valid SDA output following SCL LOW.

^[5] $t_{VD;ACK}$ = time for acknowledgement signal from SCL LOW to SDA output LOW.

Automotive LCD driver for multiplex rates up to 1:8

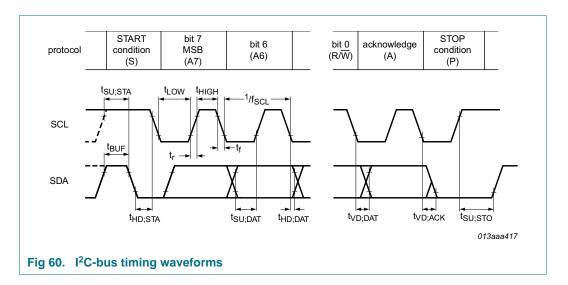
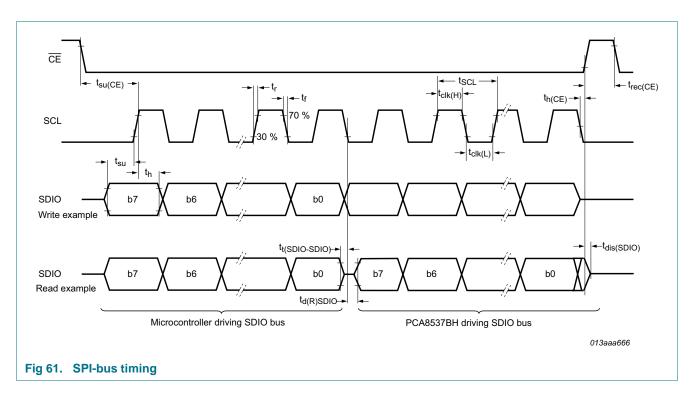


Table 40. Timing characteristics: SPI-bus

 $V_{DD} = 1.8 \text{ V to } 5.5 \text{ V}; V_{SS} = 0 \text{ V}; T_{amb} = -40 ^{\circ}\text{C}$ to +95 $^{\circ}\text{C}$. All timing values are valid within the operating supply voltage and temperature range and referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .

Symbol	Parameter	Conditions	V _{DD} <	< 2.7 V	V _{DD} ≥	2.7 V Max	Unit
			Min	Max	Min	Max	
Timing cha	racteristics (see Figure 61)	,					
f _{clk(SCL)}	SCL clock frequency		-	2	-	5	MHz
t _{SCL}	SCL time		500	-	200	-	ns
t _{clk(H)}	clock HIGH time		200	-	80	-	ns
t _{clk(L)}	clock LOW time		200	-	80	-	ns
t _r	rise time	for SCL signal	-	100	-	100	ns
t _f	fall time	for SCL signal	-	100	-	100	ns
$t_{su(\overline{CE})}$	CE set-up time		150	-	80	-	ns
t _{h(CE)}	CE hold time		0	-	0	-	ns
$t_{rec(\overline{CE})}$	CE recovery time		100	-	100	-	ns
t _{su}	set-up time	set-up time for SDI data	35	-	10	-	ns
t _h	hold time	hold time for SDI data	25	-	15	-	ns

Automotive LCD driver for multiplex rates up to 1:8



15. Test information

15.1 Quality information

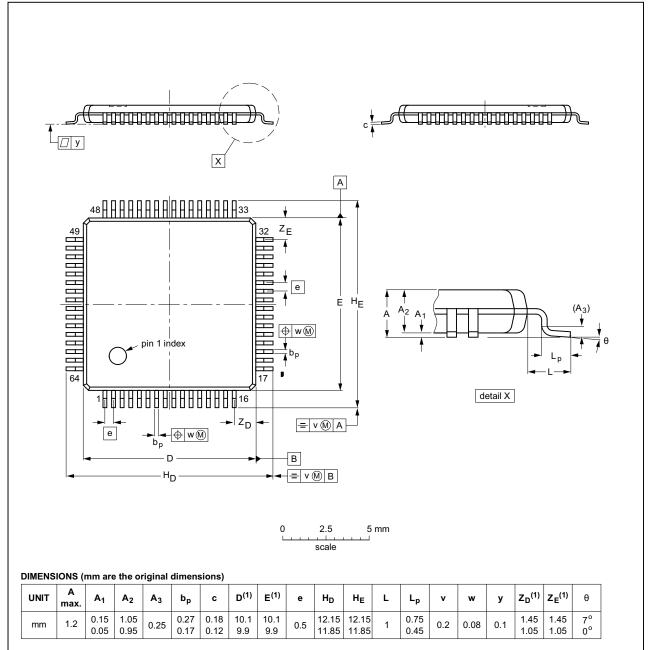
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

Automotive LCD driver for multiplex rates up to 1:8

16. Package outline

TQFP64: plastic thin quad flat package; 64 leads; body 10 x 10 x 1.0 mm

SOT357-1



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT357-1	137E10	MS-026				00-01-19 02-03-14	
				1			

Fig 62. Package outline SOT357-1 (TQFP64)

CA8537

Automotive LCD driver for multiplex rates up to 1:8

17. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

18. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

18.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

18.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

Automotive LCD driver for multiplex rates up to 1:8

18.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

18.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 63</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 41 and 42

Table 41. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)					
	Volume (mm³)					
	< 350	≥ 350				
< 2.5	235	220				
≥ 2.5	220	220				

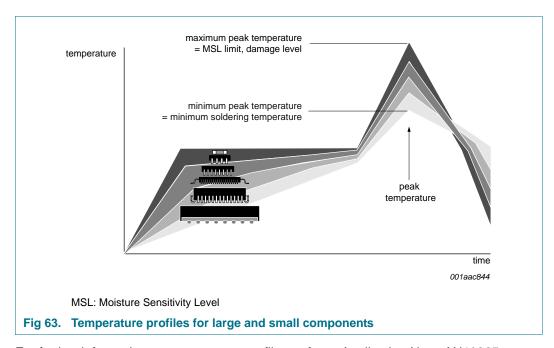
Table 42. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)							
	Volume (mm³)							
	< 350	350 to 2000	> 2000					
< 1.6	260	260	260					
1.6 to 2.5	260	250	245					
> 2.5	250	245	245					

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 63.

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For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

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19. Appendix

19.1 LCD segment driver selection

Table 43. Selection of LCD segment drivers

Type name		Number of elements at MUX					UX		$V_{DD}(V) V_{LCD}(V)$	f _{fr} (Hz)	V _{LCD} (V)	V _{LCD} (V)	T _{amb} (°C)	
		1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.	
	PCA8553DTT	40	80	120	160	-	-	-	1.8 to 5.5	1.8 to 5.5	32 to 256[1]	N	N	-40 to 105
	PCA8546ATT	-	-	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 95
	PCA8546BTT	-	-	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 95
	PCA8547AHT	44	88	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 95
	PCA8547BHT	44	88	-	176	-	-	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 95
	PCF85134HL	60	120	180	240	-	-	-	1.8 to 5.5	2.5 to 6.5	82	N	N	-40 to 85
	PCA85134H	60	120	180	240	-	-	-	1.8 to 5.5	2.5 to 8	82	N	N	-40 to 95
	PCA8543AHL	60	120	-	240	-	-	-	2.5 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 105
	PCF8545ATT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 5.5	60 to 300[1]	N	N	-40 to 85
	PCF8545BTT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 5.5	60 to 300[1]	N	N	-40 to 85
	PCF8536AT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 85
	PCF8536BT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 85
	PCA8536AT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 95
	PCA8536BT	-	-	-	176	252	320	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	N	N	-40 to 95
	PCF8537AH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 85
	PCF8537BH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 85
	PCA8537AH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 95
	PCA8537BH	44	88	-	176	276	352	-	1.8 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 95
	PCA9620H	60	120	-	240	320	480	-	2.5 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 105
	PCA9620U	60	120	-	240	320	480	-	2.5 to 5.5	2.5 to 9	60 to 300[1]	Υ	Υ	-40 to 105
	PCF8576DU	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	77	N	N	-40 to 85
	PCF8576EUG	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 6.5	77	N	N	-40 to 85
	PCA8576FUG	40	80	120	160	-	-	-	1.8 to 5.5	2.5 to 8	200	N	N	-40 to 105
	PCF85133U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 6.5	82, 110 ²	N	N	-40 to 85
	PCA85133U	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 8	82, 110 ^[2]	N	N	-40 to 95
									1	1	1	1		1

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Table 43. Selection of LCD segment drivers ...continued

Type name	Num	Number of elements at MUX						V _{DD} (V) V	V _{LCD} (V)	f _{fr} (Hz)	V _{LCD} (V)	V _{LCD} (V)	T _{amb} (°C)
	1:1	1:2	1:3	1:4	1:6	1:8	1:9				charge pump	temperature compensat.	
PCA85233UG	80	160	240	320	-	-	-	1.8 to 5.5	2.5 to 8	150, 220 ^[2]	N	N	-40 to 105
PCF85132U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	60 to 90[1]	N	N	-40 to 85
PCA8530DUG	102	204	-	408	-	-	-	2.5 to 5.5	4 to 12	45 to 300[1]	Υ	Υ	-40 to 105
PCA85132U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	60 to 90[1]	N	N	-40 to 95
PCA85232U	160	320	480	640	-	-	-	1.8 to 5.5	1.8 to 8	117 to 176[1]	N	N	-40 to 95
PCF8538UG	102	204	-	408	612	816	918	2.5 to 5.5	4 to 12	45 to 300[1]	Υ	Υ	-40 to 85
PCA8538UG	102	204	-	408	612	816	918	2.5 to 5.5	4 to 12	45 to 300[1]	Υ	Υ	-40 to 105

^[1] Software programmable.

^[2] Hardware selectable.

Automotive LCD driver for multiplex rates up to 1:8

20. Abbreviations

Table 44. Abbreviations

Acronym	Description
AEC	Automotive Electronics Council
CMOS	Complementary Metal Oxide Semiconductor
DC	Direct Current
EPROM	Erasable Programmable Read-Only Memory
НВМ	Human Body Model
I ² C	Inter-Integrated Circuit bus
IC	Integrated Circuit
LCD	Liquid Crystal Display
LSB	Least Significant Bit
MSB	Most Significant Bit
MSL	Moisture Sensitivity Level
MUX	Multiplexer
OTP	One Time Programmable
PCB	Printed-Circuit Board
POR	Power-On Reset
RC	Resistance-Capacitance
RAM	Random Access Memory
RMS	Root Mean Square
SCL	Serial Clock Line
SDA	Serial DAta line
SMD	Surface Mount Device
SPI	Serial Peripheral Interface

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21. References

- [1] AN10365 Surface mount reflow soldering description
- [2] AN10853 ESD and EMC sensitivity of IC
- [3] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [4] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [5] IPC/JEDEC J-STD-020D Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [6] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [7] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [8] JESD78 IC Latch-Up Test
- [9] **JESD625-A** Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [10] NX3-00092 NXP store and transport requirements
- [11] SNV-FA-01-02 Marking Formats Integrated Circuits
- [12] UM10204 I²C-bus specification and user manual

Automotive LCD driver for multiplex rates up to 1:8

22. Revision history

Table 45. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
PCA8537 v.2	20150407	Product data sheet - PCA8537					
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
	new company name where approp	e appropriate.					
	Adjusted Figure 32						
	 Fixed typos 						
PCA8537 v.1	20120531	Product data sheet	-	-			

Automotive LCD driver for multiplex rates up to 1:8

23. Legal information

23.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PCA8537

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